

<u>Research at high Altitude on Distributed Irradiance Aboard an iNexpensive Cubesat Experiment</u>

Preliminary Design Review

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Team Members: Russell Bjella, Katelyn Dudley, David Varley, Lance Walton









Customer

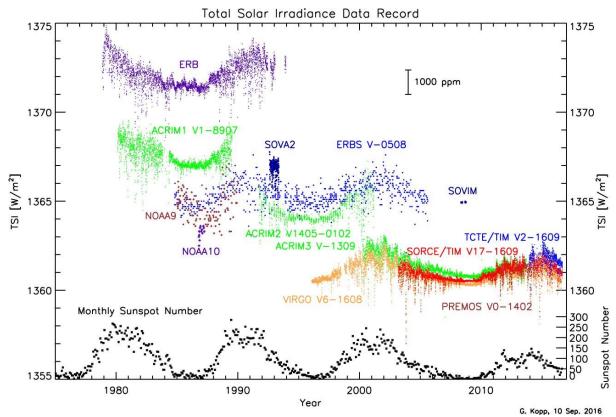




NATIONAL CENTER FOR ATMOSPHERIC RESEARCH



Project Motivation





- Solar irradiance data is plentiful, but...
 - > The record has gaps
 - Datasets vary between different instruments
 - Full-scale space missions are costly
 - Full-scale space missions are timeconsuming

Are these variations real? How does it inform climate science?

Project
OverviewBaseline
DesignCritical Project
ElementsSubsystem
FeasibilityConclusions

Mission Statement

RADIANCE is a 3U CubeSat-style payload that will collect solar irradiance data, images, and ambient atmospheric data during a 2-week circumpolar high-altitude balloon flight.

The mission will launch from Antarctica between November 2017 and February 2018.



Project Statement



RADIANCE will design, build, test, and deliver a 3U CubeSat-style payload to collect solar irradiance data, images, and ambient atmospheric data on a high-altitude balloon flight in Winter 2017/2018.



The HiWind Gondola



Project
OverviewBaseline
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Feasibility

Project Objectives

RADIANCE shall...

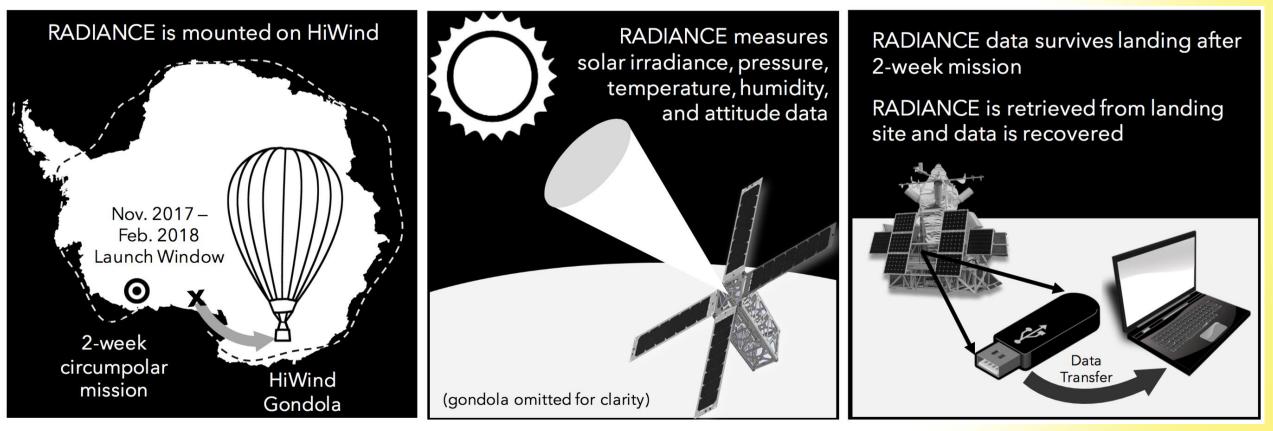
- 1. Take solar irradiance measurements.
- 2. Survive the environmental conditions of a high-altitude balloon flight up to 40 km.
- 3. Return data.
- 4. Determine its attitude.
- 5. Interface with the HiWind Gondola.
- 6. Capture images of the Sun in the visible spectrum.

The project deliverables shall include a Path-to-Space report.



Concept of Operations

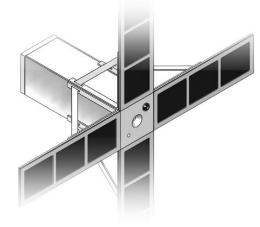






Power Up

Using external power source equivalent to 13 W of expected solar power



System Check-Out

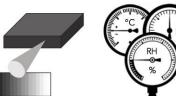
All systems run through health-and-safety checks to establish functionality before becoming operational





Attitude Determination Storage Medium

Visual Imaging





Spectrometer

Power

Thermal

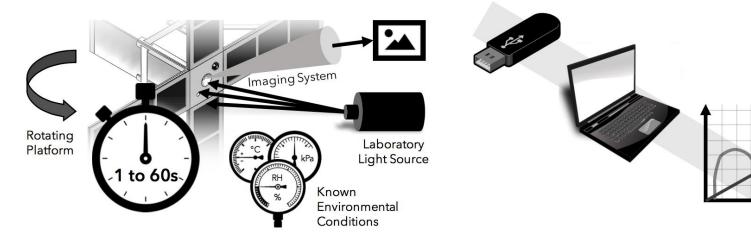
Take Data

Record data from sensors, imaging system, spectrometer, and attitude determination system every 1-60 seconds for the duration of the test

Power Down & Retrieve Data

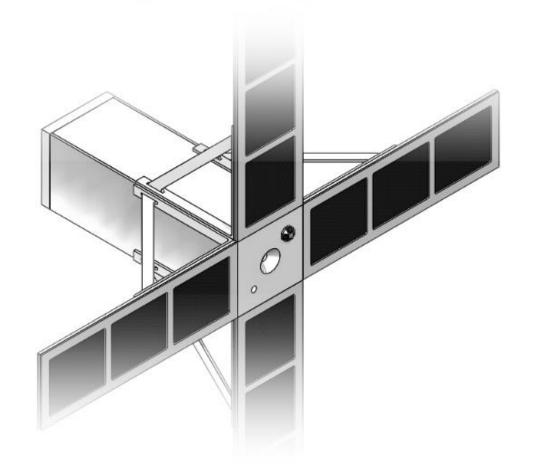
Sensor Package

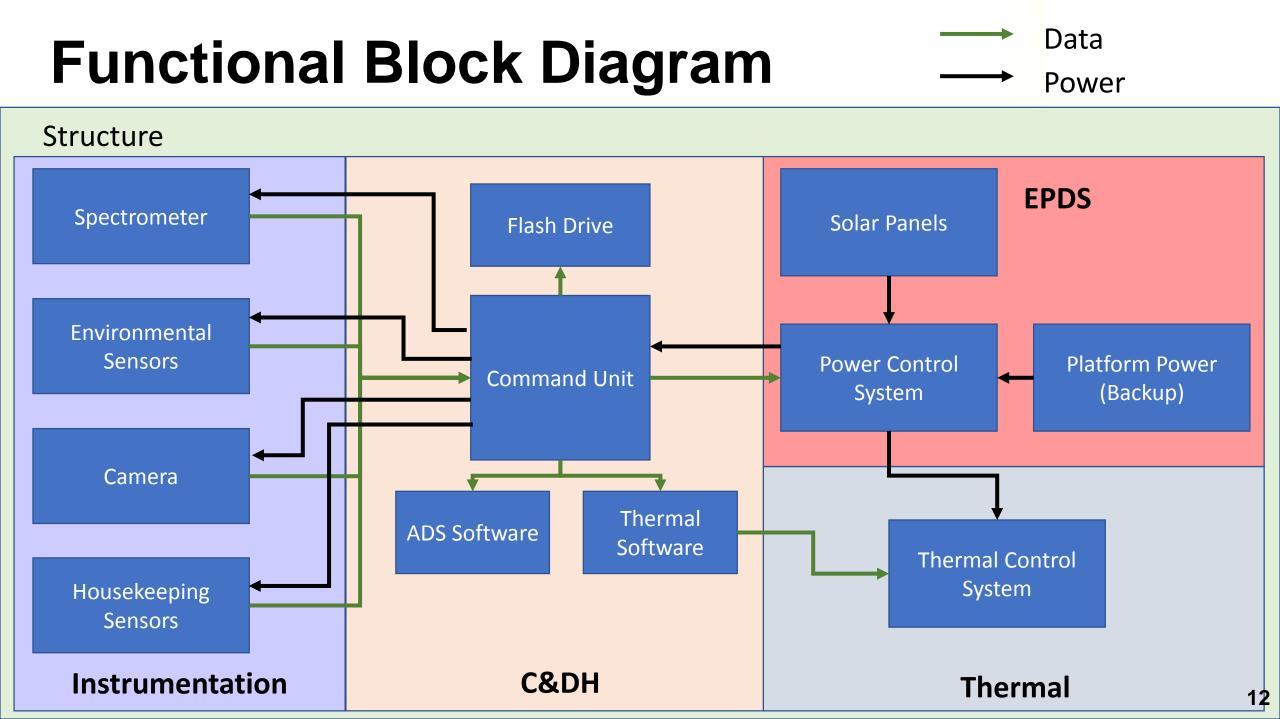
Operations finish, and data is retrieved from the storage medium for comparison with predicted models



Power Up

Using external power source equivalent to 13 W of expected solar power





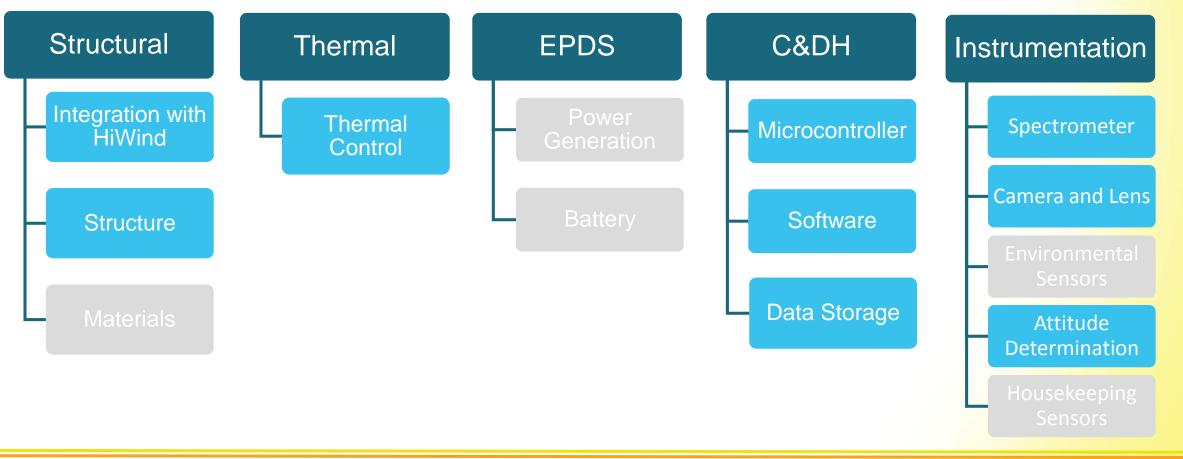


Baseline Design Overview



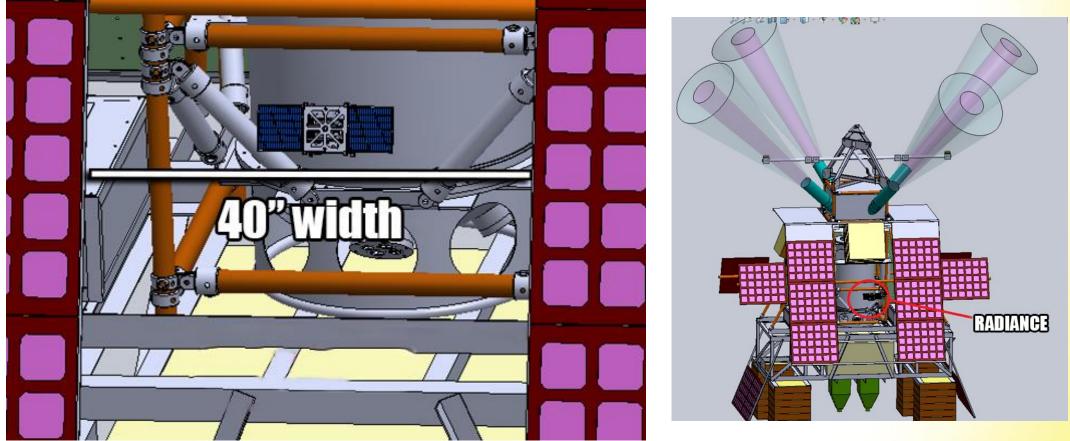
Baseline Design Topics







Integration with HiWind



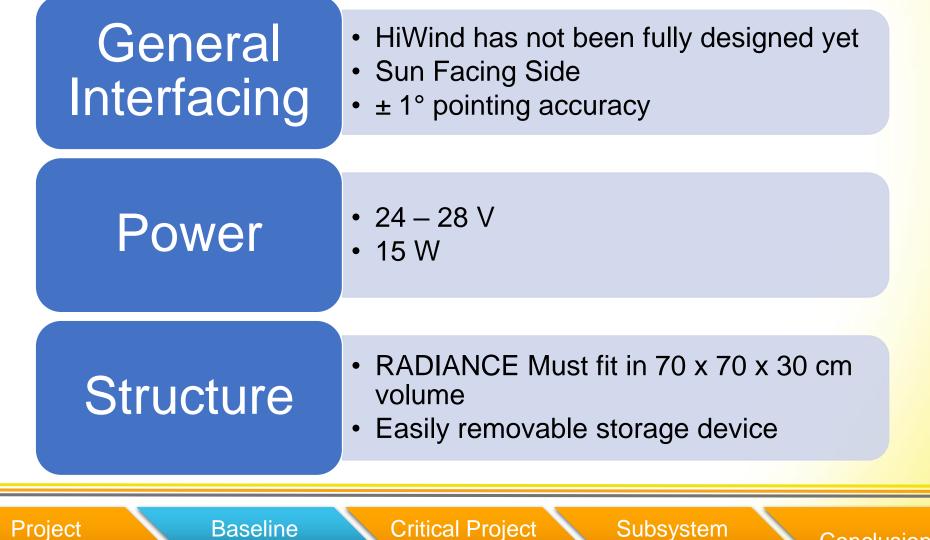
Project Overview Baseline Design Critical Project Elements Subsystem Feasibility

Integration with HiWind

Design

Overview





Elements

Feasibility

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Structure Baseline Design

Baseline

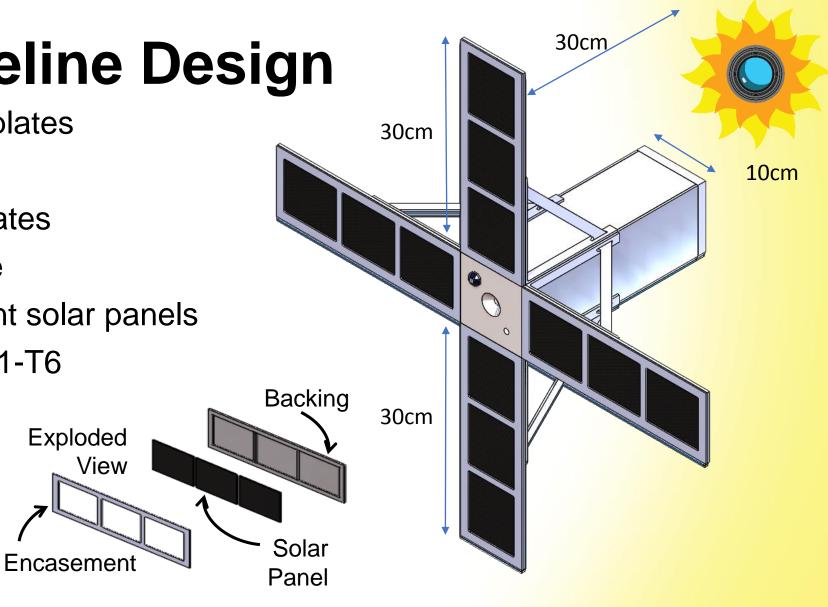
Design

- Front and Back interface plates
- Interior support struts

Project

Overview

- External mounted solid plates
- Layered solar panel frame
- Support brackets for mount solar panels
- Made from Aluminum 6061-T6



Subsystem

Feasibility

Critical Project

Elements

Thermal Control Baseline Design

Active Thermal Control

Resistive heaters

Project

Overview

Affixed to internal structures

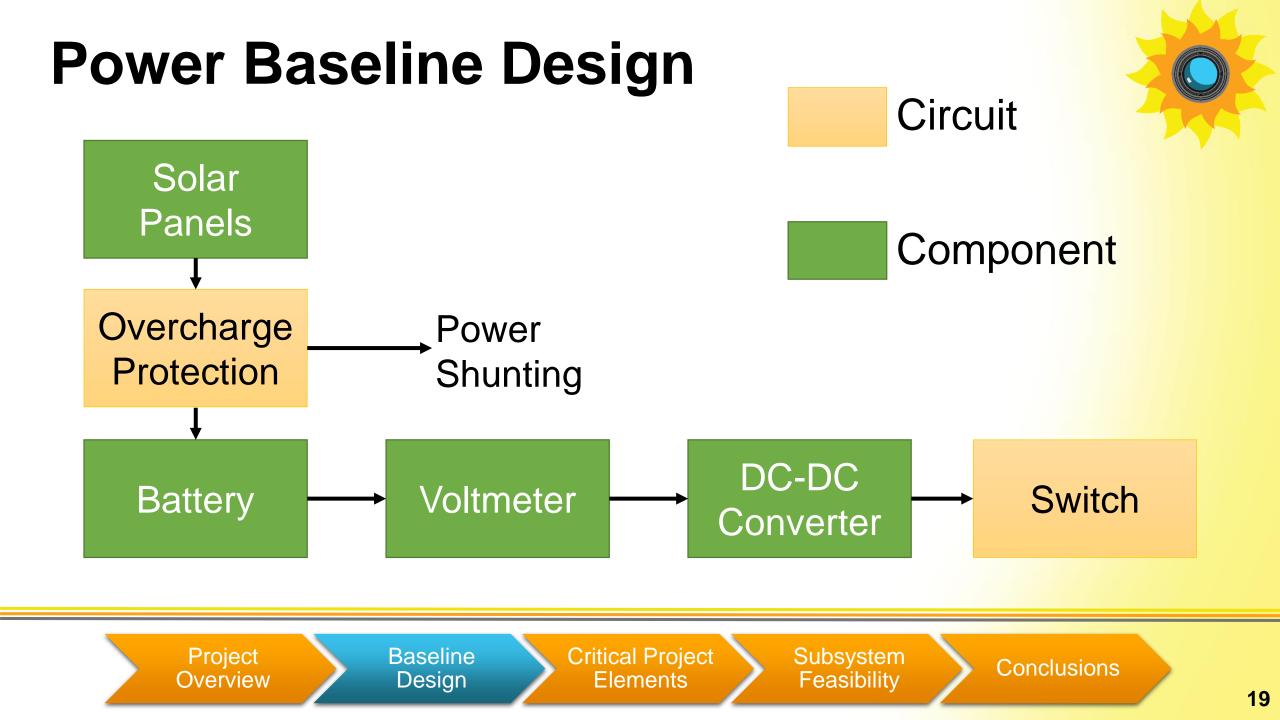
Passive Thermal Controls
 1cm Polyurethane foam liner insulation

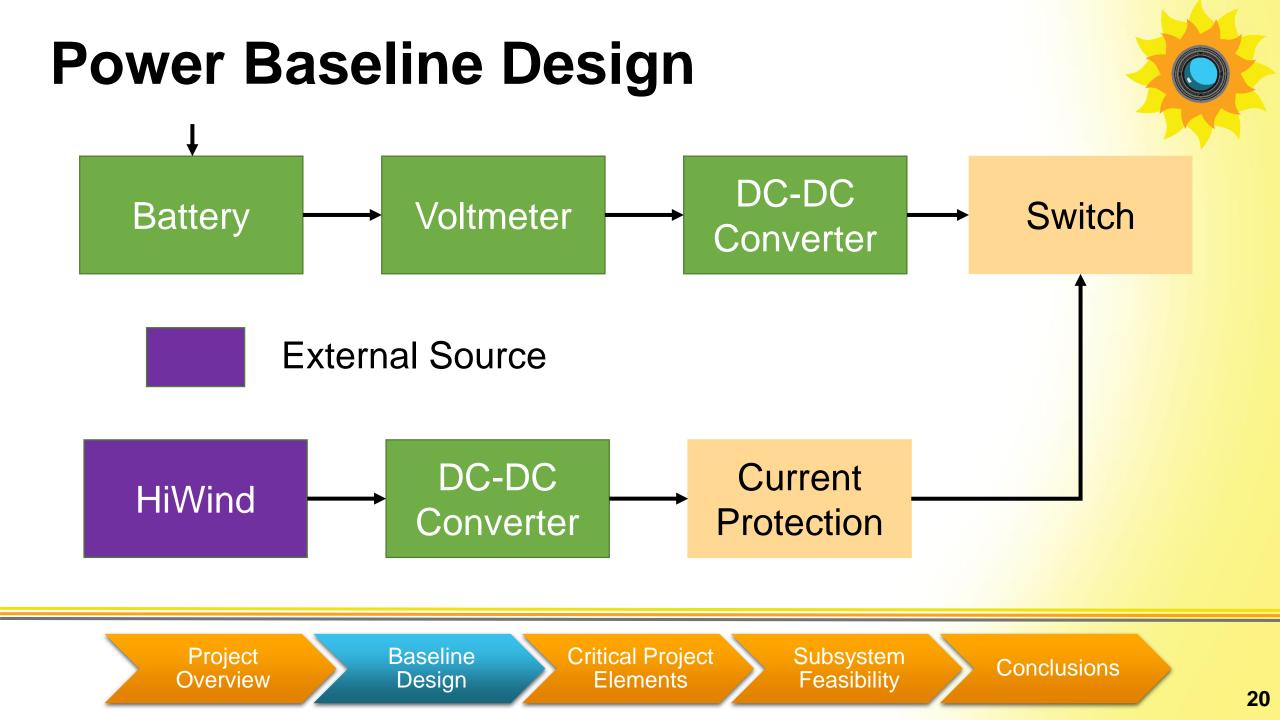
Baseline

Design

Subsystem

Feasibility





Microcontroller Baseline Design Raspberry Pi Model 3 B CPU 1.2 GHz quad-core 4 USB, 40 GPIO Interface **OS** Storage 1 microSD Slot 34 mm OS Raspbian 76 mm 122 mm Project **Critical Project Baseline Subsystem** Conclusions Overview Design Elements Feasibility 21

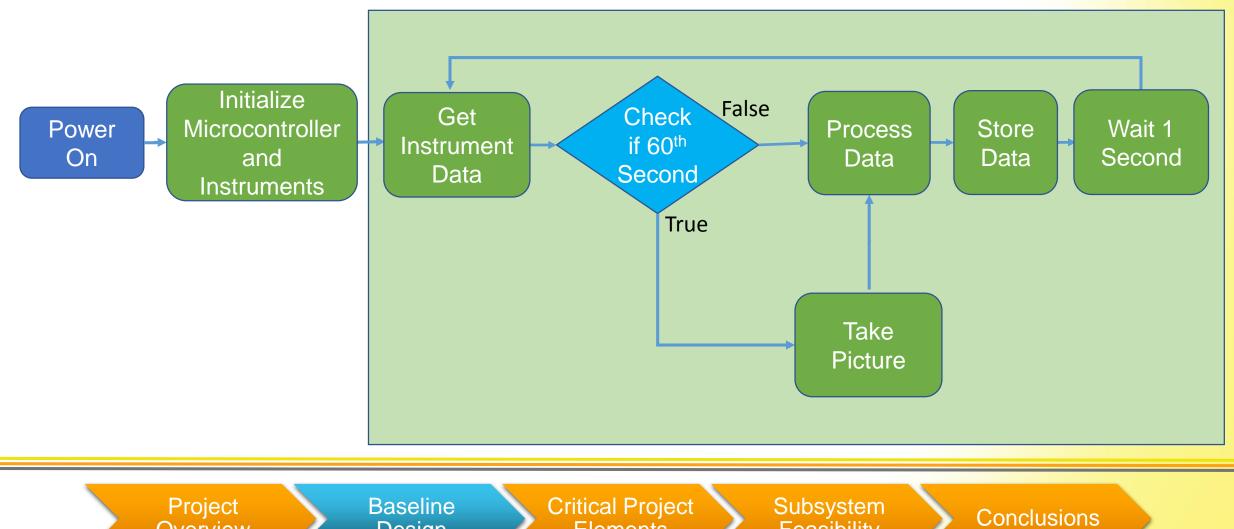
Software Flow

Overview



System Loop

Feasibility



Elements

Design

Data Storage Baseline Design

Samsung MUF-128BB/AM 128GB* Flash Drive

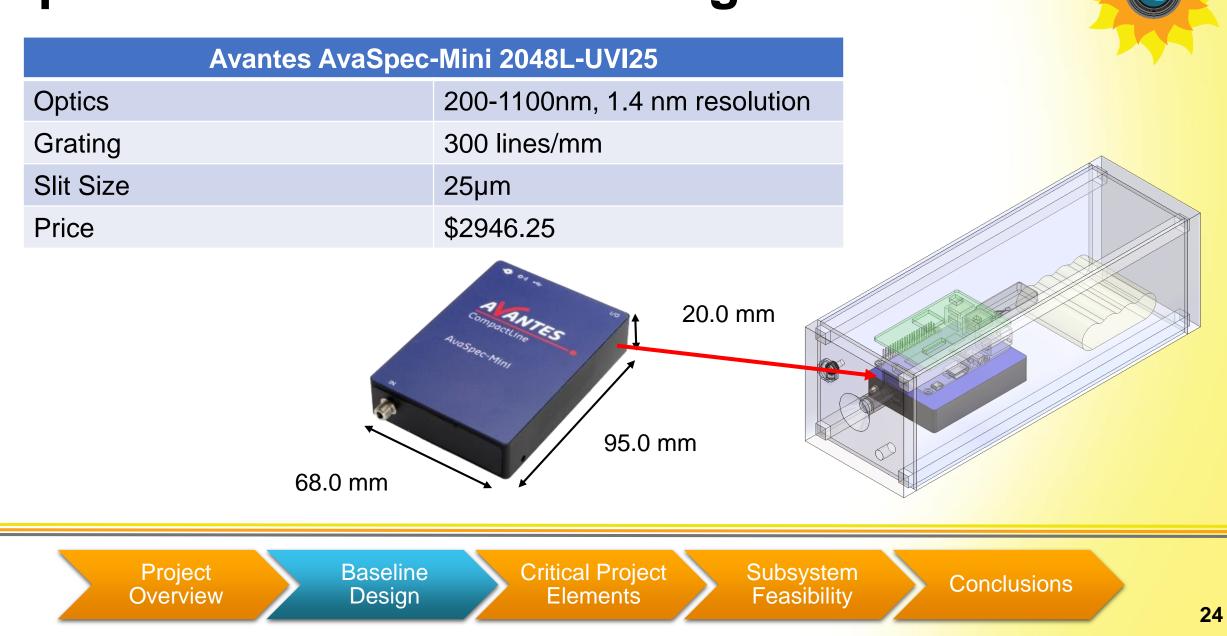
Transfer Speed	130 MB/s
Storage Capacity	119 GB

- > Additional Notes:
 - Shock Resistant



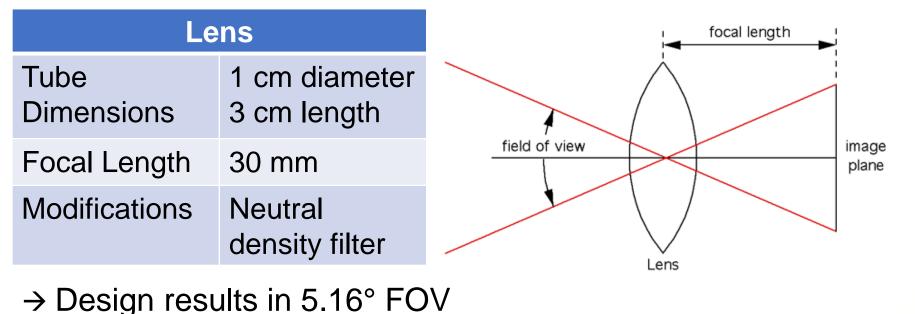


Spectrometer Baseline Design

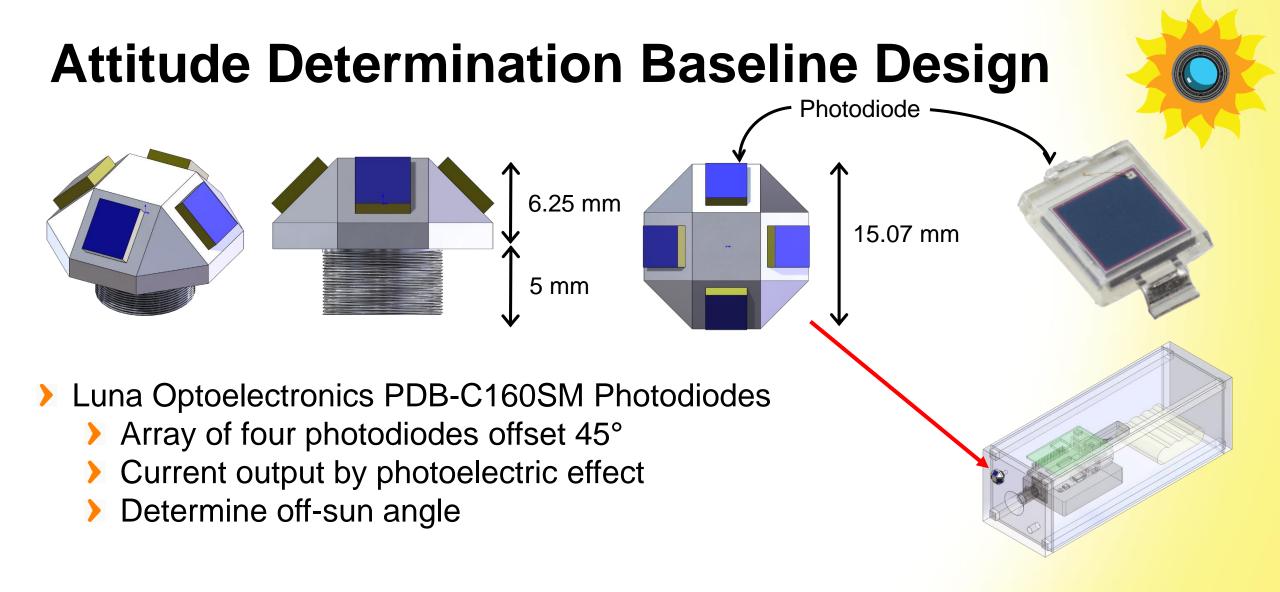


Camera and Lens Baseline Design

- Raspberry Pi Camera Module V2
 - Remove provided lens
 - Replace with separate lens





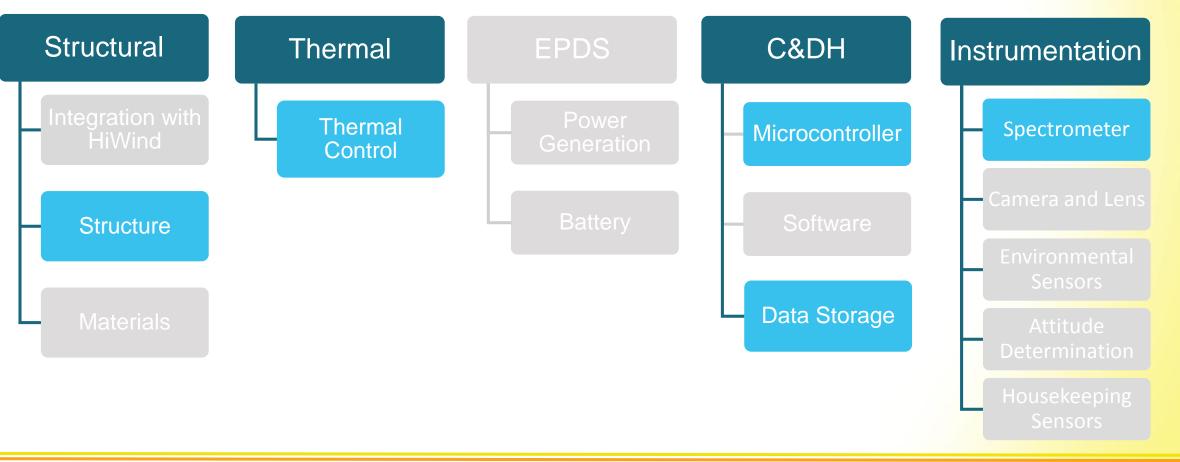




Identification of Critical Project Elements

Project Overview Baseline Design Critical Project Elements Feasibility Conclusions

Critical Project Elements





Subsystem Feasibility Analysis

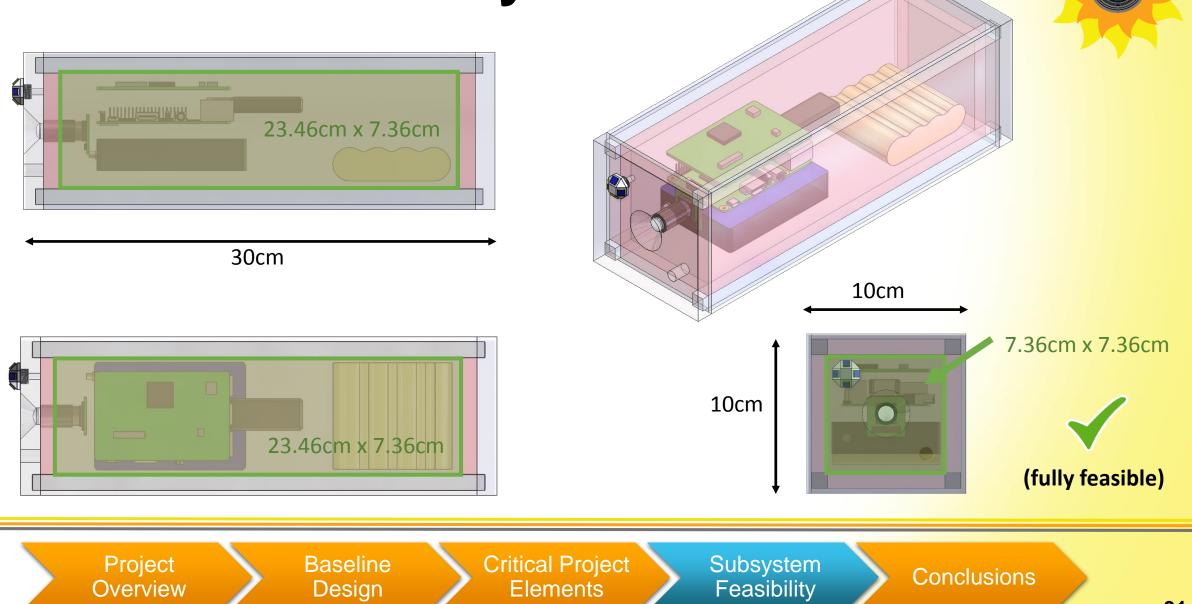
Project Overview Baseline Design Critical Project Elements Feasibility Conclusions

Structure Feasibility

Requirement	Description
5.1	The system (excluding the solar panels) shall have dimensions of 30 cm x 10 cm x 10 cm.
5.2	The system (including the solar panels) shall not exceed dimensions of 70 cm x 70 cm x 30 cm (height, width, and depth respectively).



Structure Feasibility



Structure Feasibility

Component	Volume (cm ³)
Aluminum Structure	697.1
Polyurethane Insulation	913.9
Spectrometer	129.2
Camera	3.41
Raspberry Pi	15.4
Power Board	10.8
Battery	97.1
Flash Drive	9.6
Total System	1876.51

Baseline

Design

Project

Overview

Total Available Volume: 3000 cm³

Cables, Sensors, Heaters, etc.: 450 cm³ ~15%

Remaining Interior Volume: 673.49 cm³ — 22.45% left



Subsystem

Feasibility

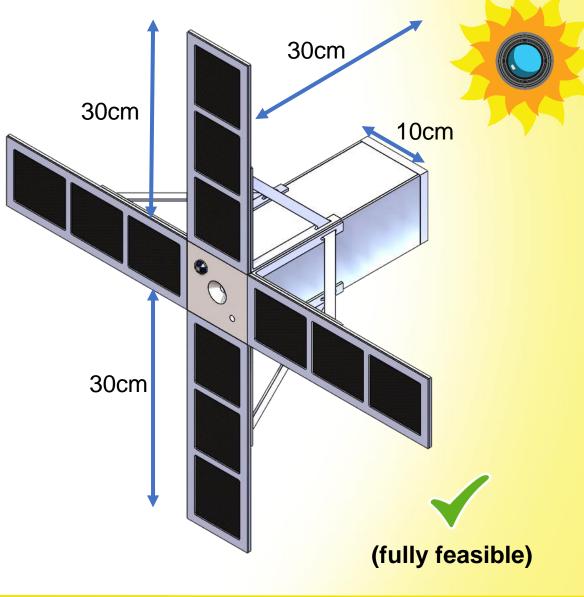
Critical Project

Elements



Structural Feasibility

Entire structure must fit within a 70cm x 70cm x 30cm envelope





Structural Feasibility

Requirement	Description	Design	Feasibility
5.1	The system (excluding the solar panels) shall have dimensions of 10 x 10 x 30 cm.	Structure is designed such that all internal components fit in the 10 x 10 x 30 cm.	
5.2	The system (including the solar panels) shall not exceed dimensions of 70 x 70 x 30 cm (height, width, and depth respectively).	Structure is designed to be exactly 70 x 70 x 30 cm (customer included margin in requirement)	



Baseline Design

Critical Project Elements

Thermal Requirements



Requirement	Description
2.1	During ascent and descent, the system shall survive temperatures from -60°C to 10°C
2.2	During cruise, the system shall operate at temperatures from 0°C to 20°C

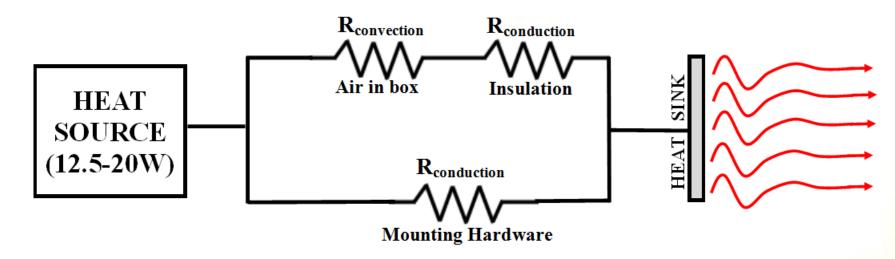


Thermal Design Model



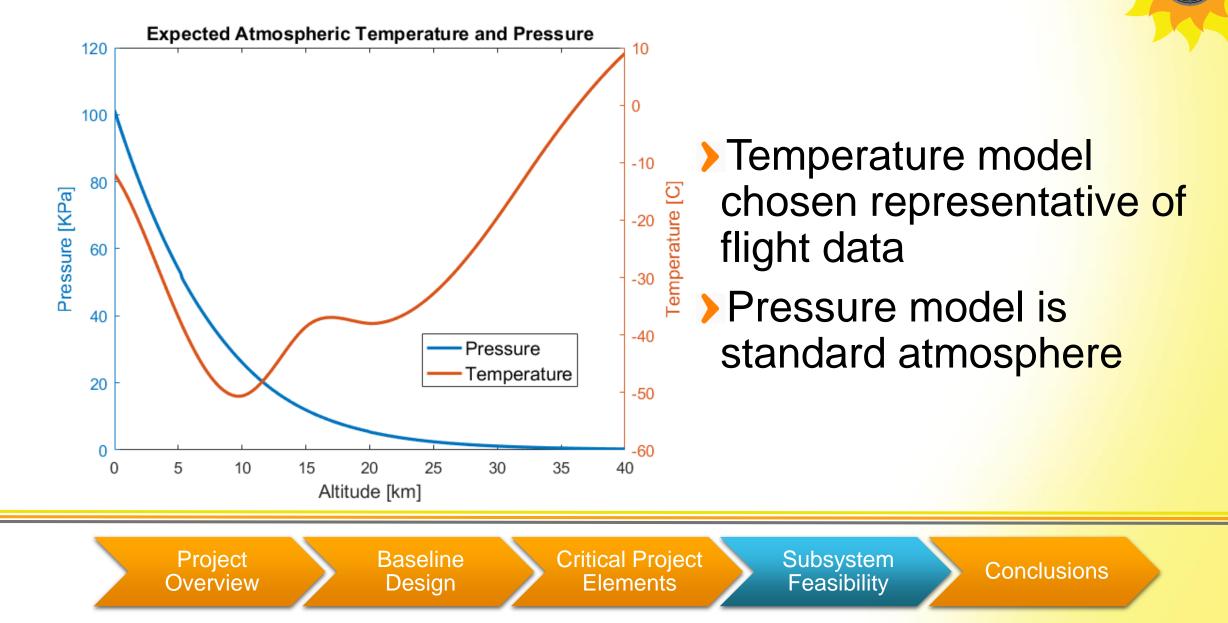
>1D Thermal model

>Heat Source \rightarrow Resistors \rightarrow Heat Sink \rightarrow Atmosphere



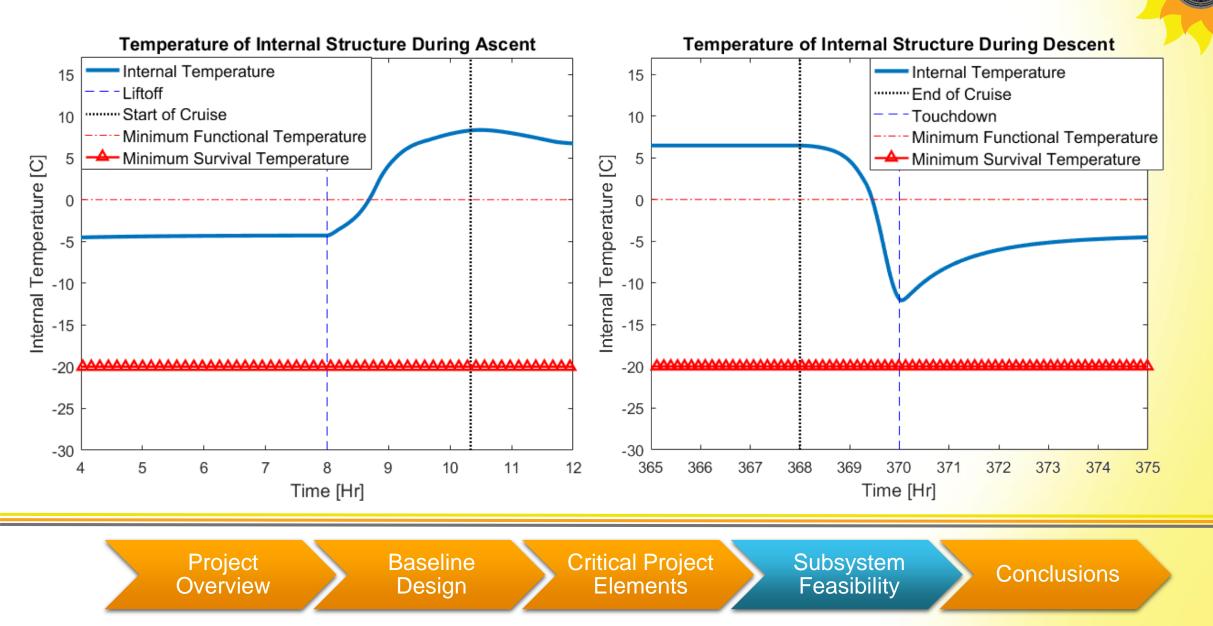


Atmospheric Model



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Ascent/Descent Thermal Profiles



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Thermal Feasibility

2	F

Requirement	Description	Design	Feasibility
2.1	During ascent and descent, the system shall survive temperatures from -60°C to 10°C	The internal structure will not drop below -13°C during ascent and descent	
2.2	During cruise, the system shall operate at temperatures from 0°C to 20°C	maintain 6°C during	



Microcontroller Requirements



Requirement	Description	Motivation
3.1.1	Science data shall be recorded at a rate of one measurement per minute.	Customer requirement; science data includes irradiance data and environmental data
3.1.2	Measurements from all science instruments shall be recorded and stored in < 1 sec.	Customer Requirement. Measurements taken at the same time can be reliably compared and correlated.
3.1.3	Camera images shall be recorded at a rate of one image per minute.	Customer Requirement. Provides context for the spectrometer data.



Microcontroller Feasibility



	Segment	Time(s)
	Measurement	0.52
All measurements must be recorded in < 1 cos	Processing	0.01
<pre>be recorded in < 1sec. >Worst case scenario > with camera</pre>	Storage	0.083
	Total	0.613 (< 1sec)

Microcontroller Feasibility



Requirement	Description	Feasibility
3.1.1	Science data shall be recorded at a rate of one measurement per minute.	\checkmark
3.1.2	Measurements from all science instruments shall be recorded and stored in < 1 sec.	
3.1.3	Camera images shall be recorded at a rate of one image per minute.	\checkmark



Baseline

Design

Project

Overview

Requirement	Description
3.1.1	Science data shall be recorded at a rate of one measurement per minute.
3.1.2	Measurements from all science instruments shall be recorded and stored in < 1 sec.
3.1.3	Camera images shall be recorded at a rate of one image per minute.
3.2	Storage medium shall survive conditions of flight, including landing.

Critical Project

Elements

Subsystem

Feasibility

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Conclusions



Component	Quantity	Measurement Size	Frequency	Total Over Flight
Spectrometer	1	4 kB	1 Hz	4.6 GB
Camera	1	2.5 MB	1/minute	49.2 GB
ENV Sensors	3	4 byte	1 Hz	13.8 MB
Attitude	5	4 byte	1 Hz	23.1 MB
HK Sensors	11	4 byte	1 Hz	50.8 MB

Total storage required: 54.1 GB Write speed required: 2564.1 kB/s (peak) Total storage available: 119.2 GB Write speed available: 8090 kB/s

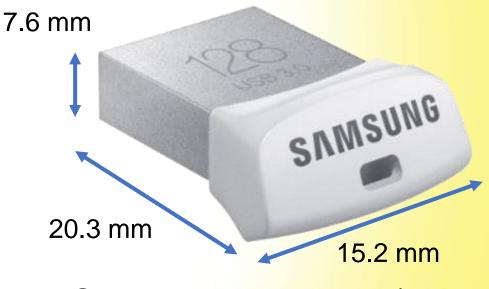




Cruise conditions: 0° to 20° Operating temperature 0° to 60°

>Ascent/descent conditions: -60° to 10° Survival temperature -10° to 70°

Expecting high G landing Can withstand up to 1500 Gs



Samsung MUF-128BB/AM



Requirement	Description	Feasibility
3.1.1	Science data shall be recorded at a rate of 1 measurement per minute.	\checkmark
3.1.2	Measurements from all science instruments shall be recorded and stored in < 1 sec.	\checkmark
3.1.3	Camera images shall be recorded at a rate of 1 image per minute.	\checkmark
3.2	Storage medium shall survive conditions of flight, including landing.	\checkmark



Instrumentation Feasibility



Requirement	Description		
1.1	Solar irradiance measurements shall be taken by a spectrometer		
1.1.1	The spectrometer shall measure spectra from 250 nm to 1000 nm		
4.1	The off-sun angle shall be determined to ± 1 arcminute.		
4.2	Attitude data shall be recorded in parallel with other environmental and housekeeping measurements at a rate of 1 Hz.		
6.2	The field of view of the camera shall be 5° (±1°)		
Project Overview	Baseline Critical Project Subsystem Design Elements Feasibility Conclusions		

Spectrometer Feasibility

	C	
		A

System	Criteria	Design	Feasibility
Optics	250nm-1000nm range	200-1100 nm range, 1.4 nm resolution	\checkmark
Power	< 3W	1.25 W	\checkmark
Interface	Ability to work with Raspberry Pi	USB2.0, Qt4 library on Raspbian	\checkmark
Size	No dimension > 10 cm	6.8 x 9.5 x 2 cm	\checkmark
Price	< \$4000	\$2947	\checkmark



Status Summary



Interface Summary: Power Budget

Subsystem	Power Consumption
Instrumentation	2.3 W
C&DH	6 W
Thermal	11.7 W
Total	20 W 关 Above 15 W of HiWind power
	aseline Critical Project Subsystem Design Elements Feasibility Conclusions

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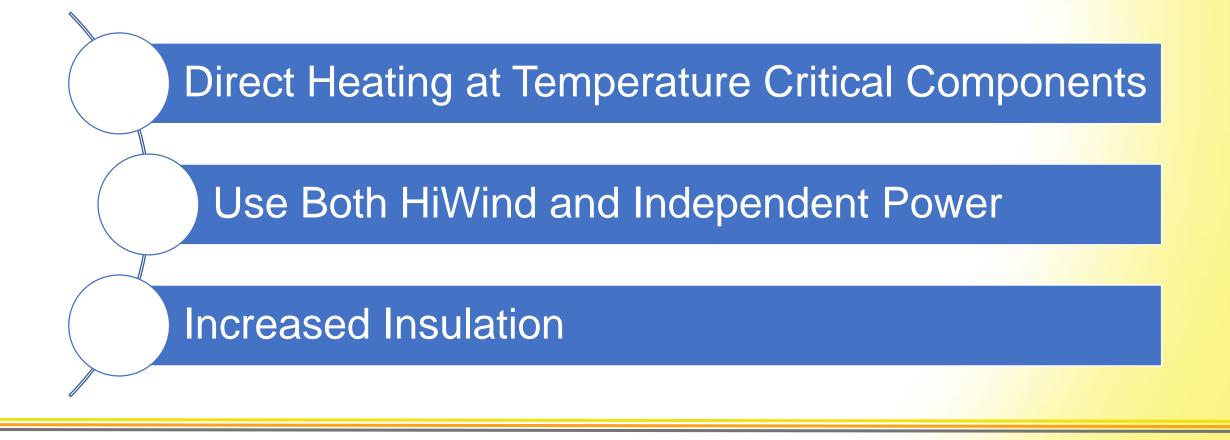
Design Options Considered

Baseline

Design

Project

Overview



Critical Project

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Interface Summary: Mass Budget

Subsystem	Mass	
Instrumentation	0.177 kg	
C&DH	0.047 kg	
Power	0.479 kg	
Thermal	0.042 kg	
Structure	2.0 kg	
Total	2.745 kg	Less Than a Lead Brick!



Feasibility and Next Steps

Baseline

Design

Project

Overview

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	I	

	Functional Requirement	Feasibility Shown	Next Steps
FR 1	The system shall take solar irradiance measurements	Spectrometer	Communicate with Vendor to Acquire Test Unit
FR 2	The system shall survive the environmental conditions of a high- altitude balloon flight up to 40 km	Thermal	CAD Model and ANSYS Model
FR 3	The system shall return data	C&DH	Mock Data Testing
FR 4	The system shall determine its attitude	Attitude	Circuit Design, Attitude Algorithm
FR 5	The system shall interface with the HiWind gondola	Structures, Power	Structure Design, Power Design
FR 6	The system shall capture images of the sun in the visible spectrum	Camera	Optics Modeling, Mock Data Testing

Critical Project

Elements

Subsystem

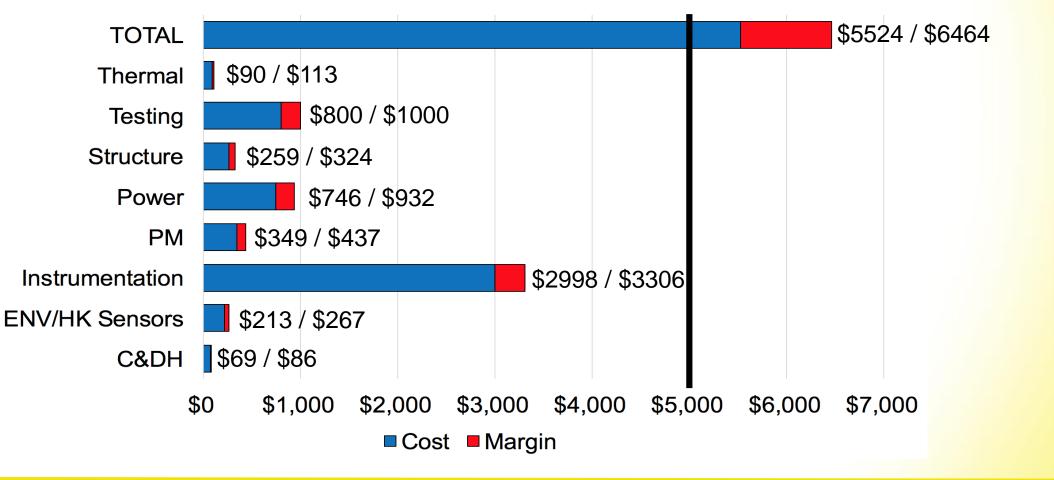
Feasibility

Conclusions

ID	Name 🔎 🦿	Start	Finish	18-Sep-16			
U	Q	Start	FILIIZII	18 Sep	25 Sep	02 Oct Q 09 C	Oct
	RADIANCE	22-Aug-16	12-Dec-16				
1	▼ PDR	26-Sep-16	11-Oct-16	PDR			
2	Write Objectives	26-Sep-16	4-Oct-16	Write Objectives			
3	Revise ConOps	26-Sep-16	4-Oct-16	Revise ConOps			
4	Revise FBD	26-Sep-16	4-Oct-16	Revise FBD			
5	Create PDR Slides	29-Sep-16	4-Oct-16	Creat	e PDR Slides		
6	Feasibility Studies	29-Sep-16	8-Oct-16	Feasi	bility Studies		
18	PDR Draft	7-Oct-16	7-Oct-16			PDR Draft	
19	Revise PDR Slides	4-Oct-16	10-Oct-16		Revise PDR Slic	des	
20	PDR Turn-In	10-Oct-16	10-Oct-16			PDR Turn-In	
21	RADIANCE PDR	11-Oct-16	11-Oct-16			RADIANCE PDR	
22	 EEF Proposal 	11-Oct-16	18-Oct-16			EEF Proposal	
23	Write EEF Narrative	11-Oct-16	13-Oct-16			Write EEF Narrative	1
24	Finalize EEF Budget	11-Oct-16	13-Oct-16			Finalize EEF Budget Proposal	1
25	Advisor Review of Pr	13-Oct-16	17-Oct-16			Advisor Review of Proposal	
26	Revise Proposal	17-Oct-16	18-Oct-16				Revise
27	EEF Deadline	20-Oct-16	20-Oct-16				
28	▼ CDR	10-Oct-16	28-Nov-16			CDR	
29	Create CDR Slides	10-Oct-16	25-Nov-16			Create CDR Slides	
30	Finalize Budget	14-Nov-16	20-Nov-16				
24		10.0 / 16	7.11 4.6			Structural Modeling	

Total Budget

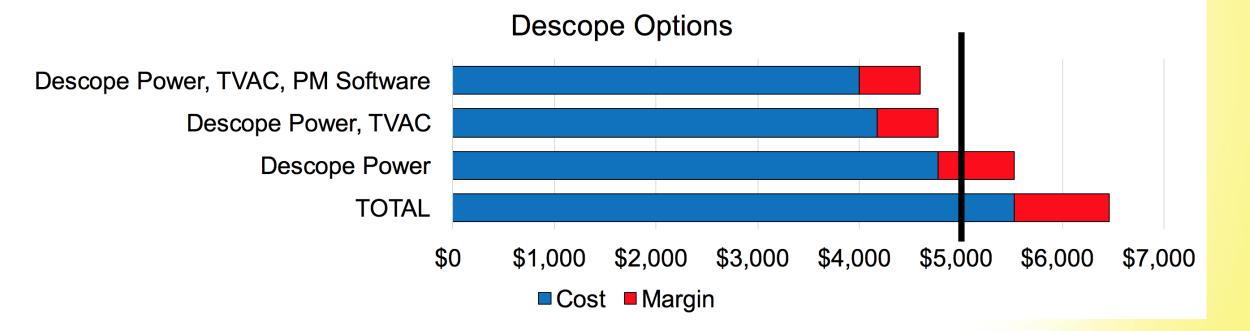
Budget with Margin





Budget: Descope Options









We welcome your feedback!

References



[1] Orozco, Luis. "Technical Article MS-2624: Optimizing Precision Photodiode Sensor Circuit Design." Analog Devices. 2014. Web.

[2] Zorzano, Maria-Paz, Javier Martin-Soler, and Javier Gomez-Elvir. "UV Photodiodes Response to Non-Normal, Non-Colimated and Diffusive Sources of Irradiance." *Photodiodes - Communications, Bio-Sensings, Measurements and High-Energy Physics* (2011): n. pag. Web.

[3] Anderson, John D. Fundamentals of Aerodynamics. McGraw-Hill Education, 2011. Print.

[4] French, John. "Middle Atmosphere Diagram." Australian Antarctic Division. N.p. 8 July 2002. Web.

[5] Lazzara, Matthew A. "Radiosonde Weather Observations over Antarctica/Southern Ocean." Antarctic Master Directory. N.p., 20 Oct. 2000. Web.

[6]Sun-Climate Research Center. "Total Solar Irradiance Record." LASP/Goddard Space Flight Center, N.d. Web. [7]UCAR. "HAO Balloon Takes To The Skies". NCAR|UCAR, 17 Jul. 2011. Web.

Image Credit

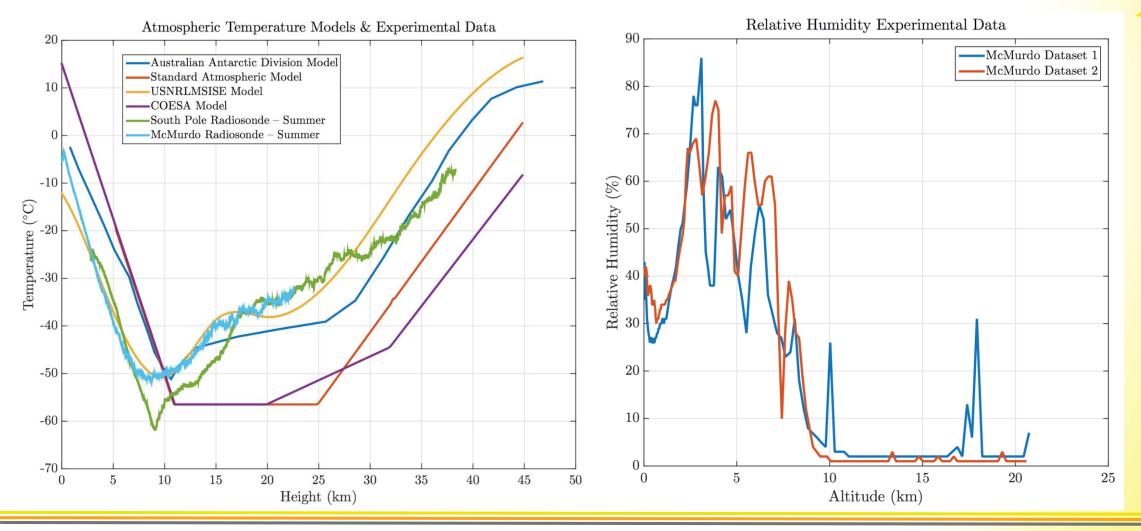
- LASP Irradiance Data http://spot.colorado.edu/~koppg/TSI/Publications/2007_Kopp_TRF_SPIE.pdf
- HiWind Gondola Photos http://stratocat.com.ar/globos/fotos/hiwind11b.jpg
- HiWind CAD Models Email from HAO-NCAR
- IXYS Solar Panel http://ixapps.ixys.com/DataSheet/SLMD481H12L_20160712.pdf
- CUTE-I CubeSat http://lss.mes.titech.ac.jp/ssp/cubesat/index_e.html
- UltraLife Battery https://www.ultralifecorporation.com/Ecommerce/site/images/Photo2/UBBL24-C1.jpg
- Avantes Spectrometer http://www.avantes.com/products/spectrometers/compactline/item/723-avaspec-mini
- Raspberry Pi http://uk.rs-online.com/web/p/processor-microcontroller-development-kits/8968660/
- Flash Drive –
- Photodiodes http://www.digikey.com/product-detail/en/luna-optoelectronics/PDB-C160SM/PDB-C160SMCT-ND/481717
- Pressure Sensor http://www.digikey.com/product-detail/en/honeywell-sensing-and-productivity-solutions/ASDXACX015PA7A5/480-3303-ND/2178292
- Humidity Sensor http://www.digikey.com/product-detail/en/te-connectivity-measurement-specialties/HPP804B130/HPP804B130-ND/697732
- ENV Temperature Sensor https://www.sparkfun.com/products/11931
- HK Temperature Sensor https://www.adafruit.com/product/374
- PTC Battery Protection http://www.nrel.gov/transportation/energystorage/pdfs/45388.pdf
- Thermocouple https://www.adafruit.com/product/270

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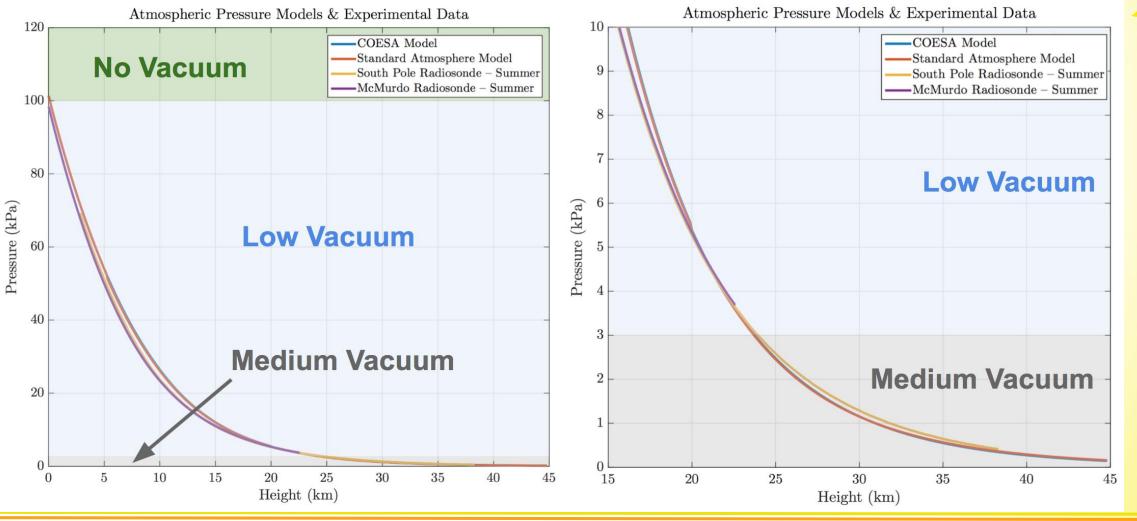
System Overview	Baseline Design	Critical Project Elements	System Feasibility	Conclusions	Backups
 Motivation Mission/Project Statement HiWind Objectives CONOPS FBD 	 Integration Structure Thermal Microcontroller Software C&DH Spectrometer Camera Attitude Determination 	• <u>Link</u>	 <u>Structure</u> <u>Thermal</u> <u>Microcontroller</u> <u>C&DH</u> <u>Spectrometer</u> 	 Power Budget Mass Budget Feasibility Gantt Chart Budget 	 <u>Atmosphere</u> <u>Models</u> <u>Materials</u> <u>Power</u> <u>Batteries</u> <u>Microcontroller</u> <u>Language</u> <u>Spectrometer</u> <u>Camera</u> <u>Sensors</u> <u>Pressure</u> <u>Humidity</u> <u>Temperature</u> <u>Attitude</u> <u>Determination</u> <u>Thermal</u> <u>Interface</u>

Backups

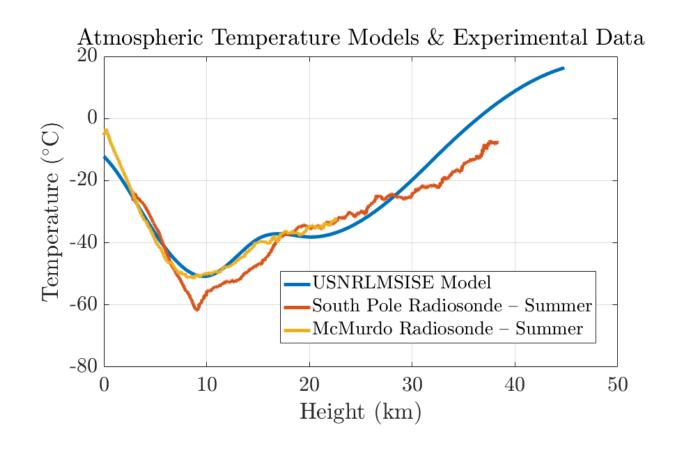
Atmospheric Models



Atmospheric Models

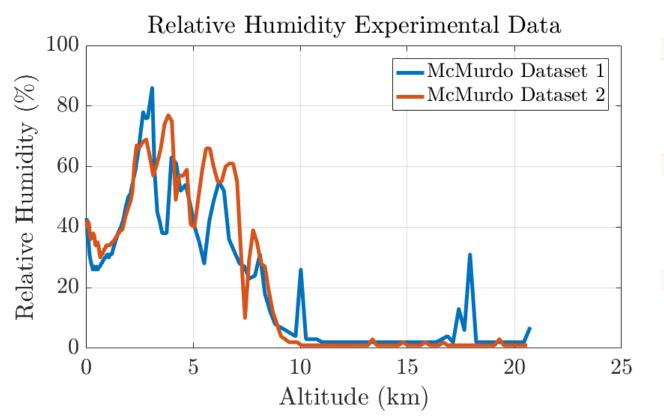


Atmosphere Justification



- Used USNRLMSISE model for continuity
- Both McMurdo datasets follow general trend of model

Atmospheric Humidity



- Humidity ranges between 0 and 90%
- Humidity decreases density which affects convection
- May result in condensation/icing on descent

Materials Selection

> Silicon: Too expensive

> Magnesium: Burns well

> Titanium: Out of budget

Iron: Oxidizes

> Honeycomb materials would be difficult to manufacture



Materials Type Trade Study

57	

Criteria (ranked by weight)		Metals		Composites		Plastics	
Price	0.35	4	1.4	2	0.70	3	1.05
Durability	0.25	4	1.0	5	1.25	1	0.25
Manufacturability	0.10	5	0.50	1	0.10	4	0.40
Density	0.05	1	0.05	3	0.15	3	0.15
Thermal Conductivity	0.05	2	0.10	3	0.15	4	0.20
Familiarity	0.05	4	0.20	1	0.05	5	0.25
Totals	1.00		3.25		2.40		2.30

Materials Selection



- AI7075 is a stronger allow that can be machined thinner consisting mostly of Zinc as the primary alloying element
- > Al6061 is a cheaper lighter alternative with Mg and Si as the primary alloying elements
- > SS 304 is the most common grade known as 'food grade'
- SS 316 is the second most common and is known as 'marine grade' and prevents specific forms of corrosion
- > SS in general is much more difficult to machine

Structure Material Feasibility

>Al6061-T6

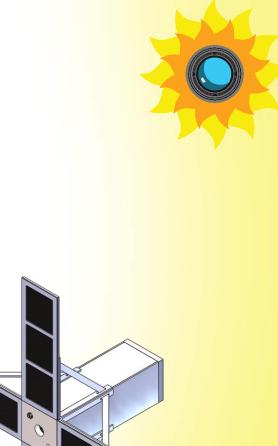
- > 2'x2' sheets of 3/16" can be bought for less than \$50
- Excellent corrosion resistance
- Lightweight
- > Easy to machine
- Vacuum and temperature resistant
- Easily available

Material Alloy Trade Study



Value	Price \$	Durability (MPa)	Ease of Manufacturing	$\begin{array}{c} \mathbf{Density} \\ \mathrm{g/cm^3} \end{array}$	Thermal Conductivity W/m/K	Familiarity
1	> 100	< 50	Need to procure equipment	> 5	> 150	No experience with material
2	100 to 50	50 to 100	Limited access to equipment	5 to 2.5	150 to 100	Knowledge of material
3	50 to 20	100 to 200	Access to equipment	2.5 to 1.5	100 to 75	Used material before
4	20 to 10	200 to 500	Easy access to equipment	1.5 to 1	75 to 50	Very experienced with material
5	< 10	> 500	Readily available equipment and techniques	< 1	< 50	Expert with material

Criteria (ranked by normalized criteria value)	Normalized Priority Value	Alumi 6061		Alum 7075		Stainles 30		Stainles 31	
Price	0.35	3	1.05	1	0.35	2	0.70	2	0.70
Durability	0.25	4	1.00	5	1.25	5	1.25	5	1.25
Manufacturability	0.10	4	0.40	3	0.30	2	0.20	2	0.20
Density	0.05	2	0.10	2	0.10	1	0.05	1	0.05
Thermal Conductivity	0.05	1	0.05	1	0.05	5	0.25	5	0.25
Familiarity	0.05	4	0.20	4	0.20	2	0.10	2	0.10
Totals	0.85		2.80		2.25		2.55		2.55

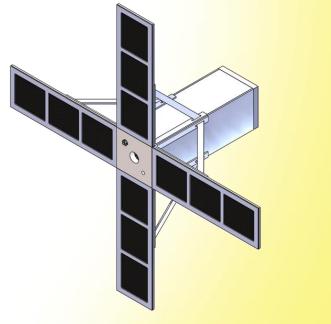


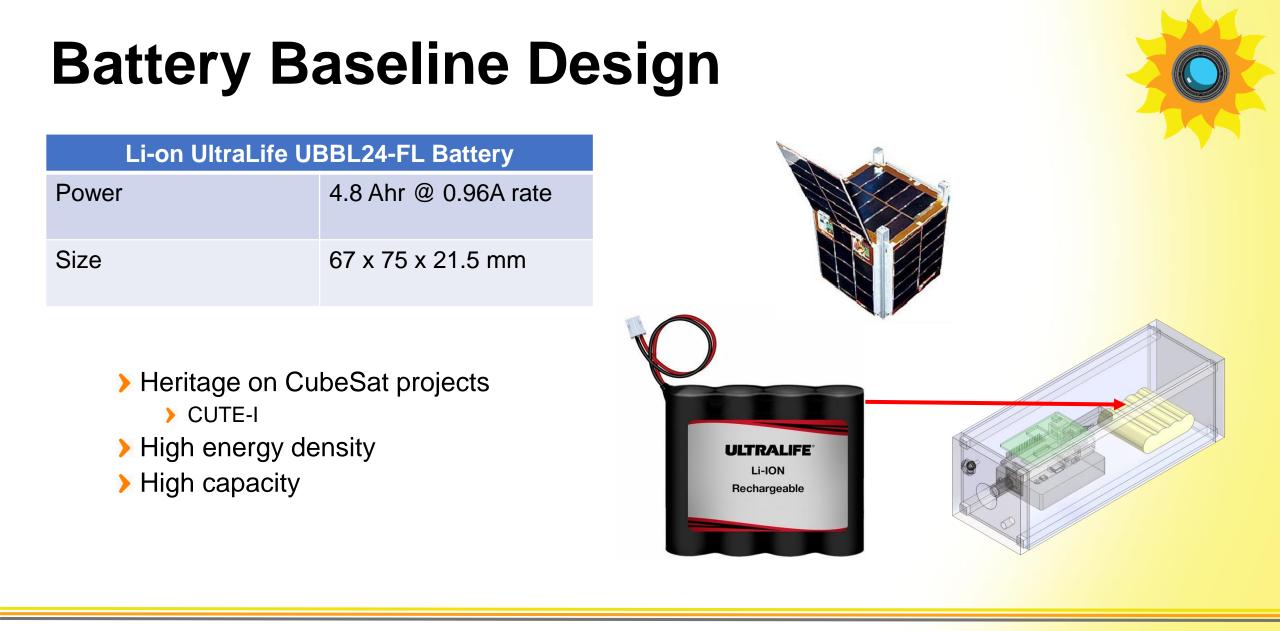
Power Feasibility: Solar Panels

- > 3 cells per panel
- > 4 panels on RADIANCE

Properties of Single Cell at Max Power Point					
Voltage (V)	Current(A)	Power = V^*I (W)			
6.06	0.178	1.079			

- > $3 \times 4 = 12$ total cells
- > Maximum total power: 12.948 W





Battery Trade Study

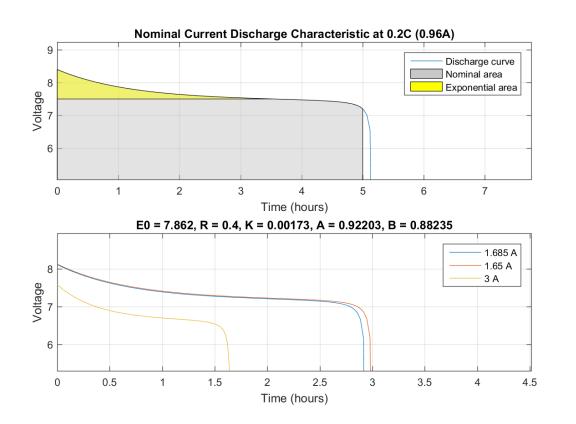
C	
	A

Criteria											
(ranked by weight)		UBBL	21-FL	UBBL	24-FL	UBE	3L20	UBB	L07	AT 18	8650
Capacity	0.40	1	0.40	4	1.60	1	0.40	5	2.00	2	0.80
Price	0.20	2	0.40	1	0.20	4	0.80	3	0.60	5	1.00
Voltage	0.20	2	0.40	5	1.00	5	1.00	1	0.20	4	0.80
Size	0.20	4	0.80	2	0.40	2	0.40	1	0.20	3	0.60
Totals	1.00		2.00		3.20		2.60		3.00		3.20

Battery Baseline Design

Ultralife UBBL24-FL				
Size	67 x 75 x 21.5mm			
Capacity	4.8 A-Hr @ 0.96 A rate			
Voltage	7.2 V			
Maximum Discharge Current	3.0 A Continuous			
Energy Density	181Wh/kg, 450Wh/l			
Weight	191 g			
Operating Temperature	-20° – 60° C			

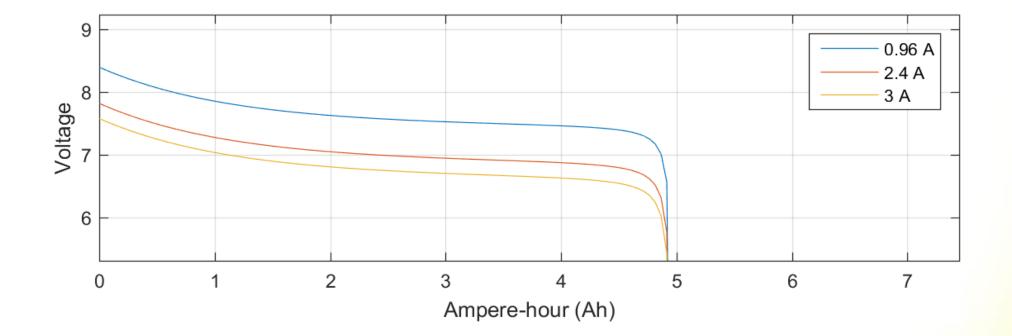


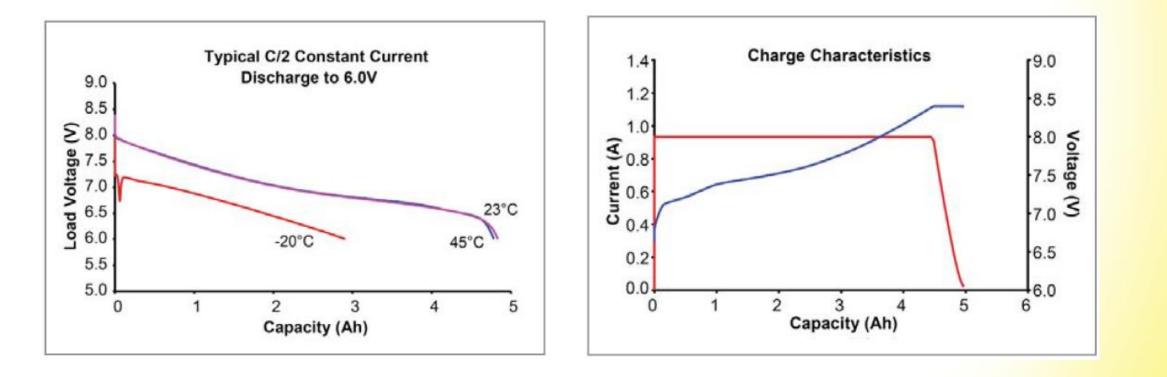


Modeled using Simulink's built in electronics library

Validated with experimental results found in Datasheets

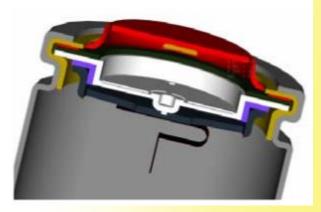
 With all sensors on, Battery will last nearly 3 hours (No thermal control)

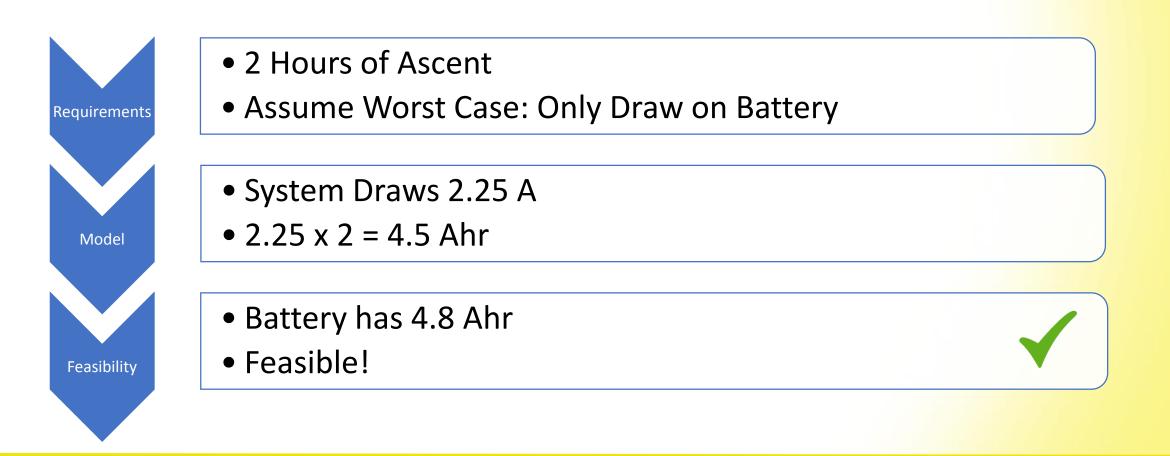




PTC

- Circuit protection
- > Stands for Pressure, Temperature, Current (sensors)
- Stops current surges
- Resettable, but deteriorates after each trigger







Microcontroller Trade Study

Criteria (ranked by normalized criteria value)	Normalized Priority Value	Raspbe Mod	erry Pi 3 lel 3		Pi Plus	Banana	a Pi M3	Odrio	d XU4
Price	0.05	5	0.25	4	0.20	3	0.15	3	0.15
Processing Speed	0.10	3	0.30	4	0.40	4	0.40	5	0.50
# of Threads	0.15	4	0.60	4	0.60	5	0.75	5	0.75
RAM	0.15	2.5	0.38	5	0.75	5	0.75	5	0.75
Power Usage	0.35	5	1.75	4	1.40	2	0.70	2	0.70
Compatibility	0.15	5	0.75	3	0.45	1	0.15	4	0.60
Familiarity	0.05	5	0.25	2	0.10	1	0.05	5	0.25
Totals	1.00		4.28		3.90		2.95		3.70

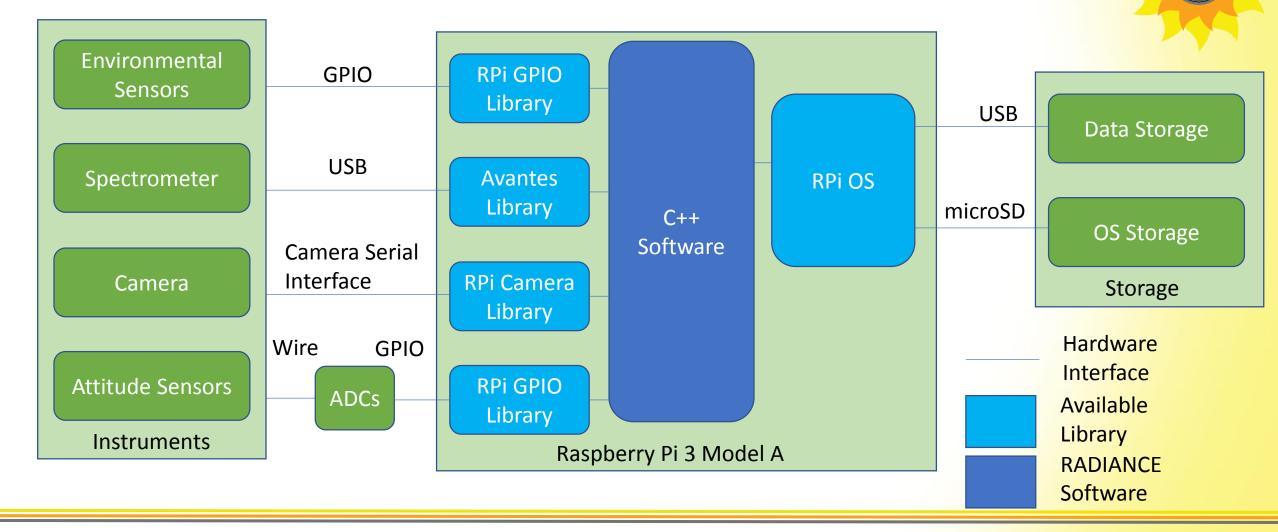
Microcontroller I/O Capability

> Spectrometer/data storage uses 2 USB ports, 4 are available

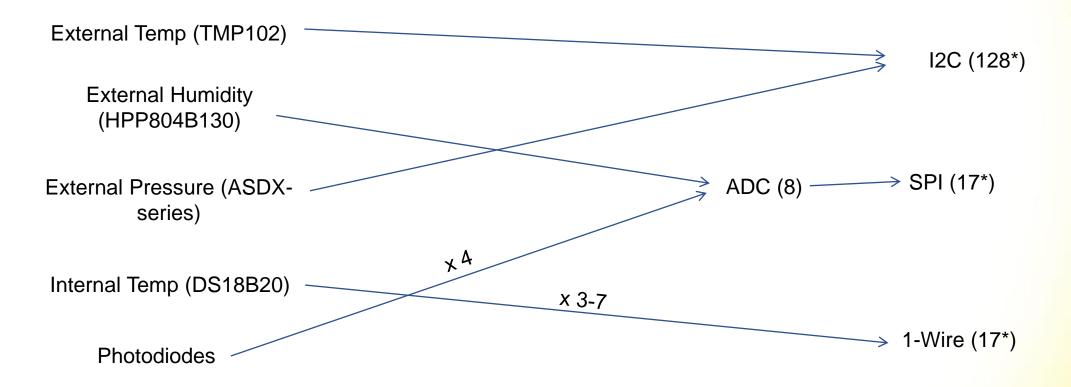
- > Camera uses CSI, 1 is available
- > OS/Storage uses microSD, 1 is available

HK sensors use a variety of protocols(I2C/SPI/1W); number of GPIO pins available may be a problem when using ~15 sensors. Worst case we solve this using a GPIO extender, best case we use clever sensor mapping

Software Interfaces



Sensor Port Mapping





Microcontroller Design(Measurements)



Quantity	Component	Time per measurement	Data Transfer Time	Total
1	Camera	Typical Exposure Time: 0.25 s	2.5MB @ 30MB/s(USB2.0) = 8.33e-2 s	0.333s
1	Spectrometer	Typical Integration Time: 0.17 s	5 kB @ 30MB/s(USB2.0) = 1.67e-4 s	0.170s
3	HK Sensors	I2C Bus Speed: 2.5e- 6 s	30B@12.5kB/s(I2C) = 2.4e-3 s	1.68e-2s
4	Attitude Sensor	ADC Sampling Rate: 1.33e-5 s	2B @ 12.5kB/s(I2C) = 1.6e-4 s	6.92e-4s



Total Measurement Time: 0.52s(<1s)



Microcontroller Design (Measurements)



Component	Time/Measurement [s]
Camera	0.333
Spectrometer	0.170
HK Sensors	0.0168
Attitude Sensor	0.000692

Total Time/Measurement: 0.52s

Execution Time Estimation

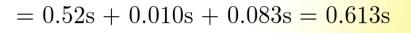
>HK and attitude sensors

- > Estimate 210B (one measurement per sensor) of raw data
- Process: Write test program on similar hardware (Raspberry Pi 1 Model B) and measure execution time
- >Answer: Test program takes 0.010s for processing all 210B

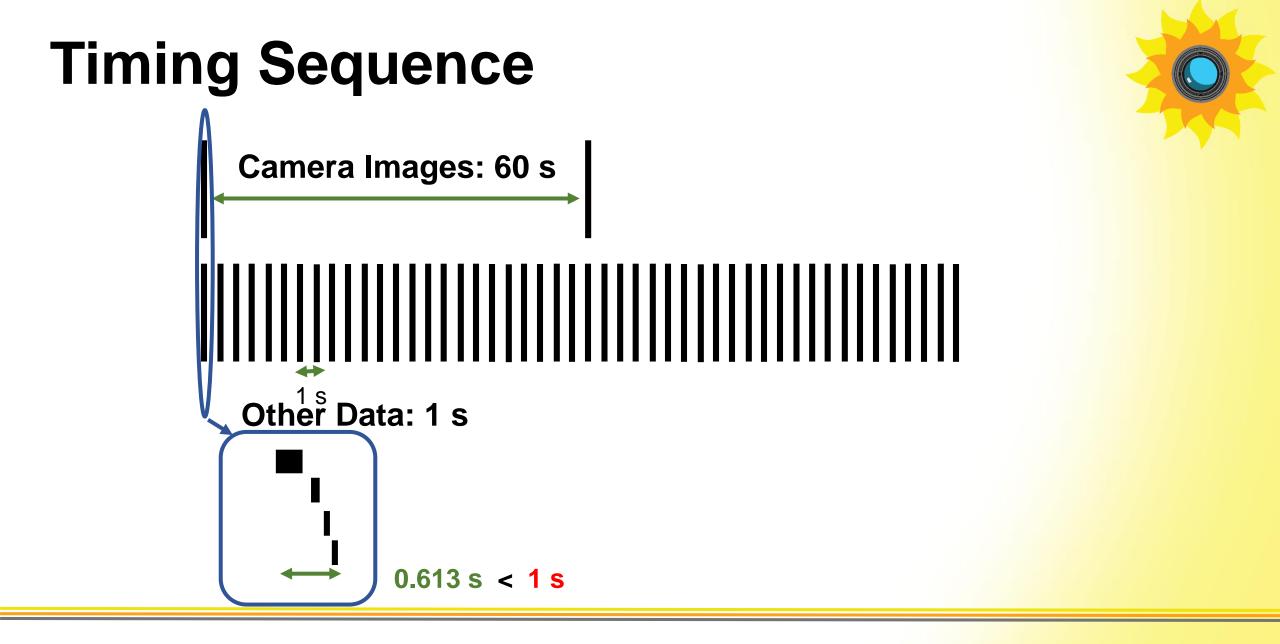
Total Processing Time: 0.010s

> Need to write 2.51MB at 30 MB/s Time Per Frame = Measurement + Processing + Storage

Data Storage Time: 0.083s







Language Selection Rationale

> Both Python and C++ are options

> Python requires the use of PyQt4 for interfacing with Avantes's library

> Our group is much more familiar with Python

> Python is interpreted and is 10-100x slower on average, worst case 400x

> Most measurements are being taken every second

> C++ has a better ability to be optimized when speed is a concern

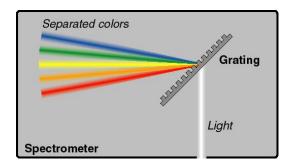


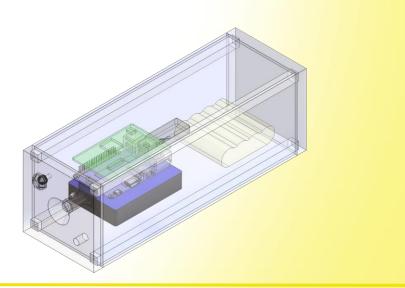
S	pectromete	r Baseline [Design
	Category	Specs	A ANTES 20.0 mm
	Power	250mA, 5V, 1.25W	95.0 mm
	Data	16 bit A/D converter 4KB per measurement 4.61 GB for full mission (1Hz)	68.0 mm
	Software	Library written in C++ Can interface with all Linux distributions	

Spectrometer Baseline Design

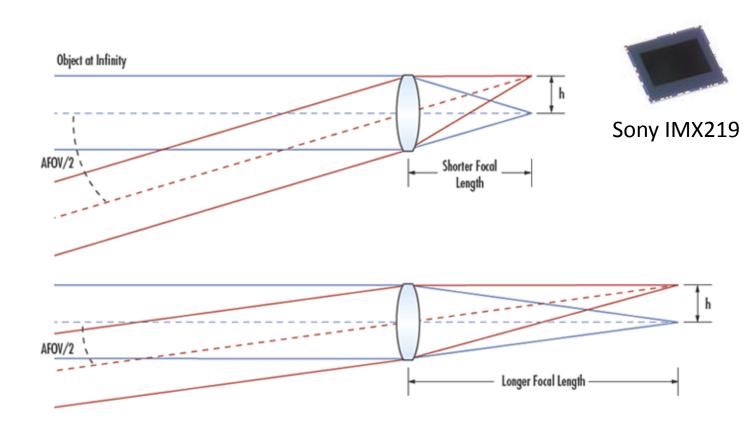
Slit size (µm)						
2048(L)						
Grating (lines/mm)	10	25	50	100	200	500
300	0.80-0.90	1.12-1.25	2.35	4.65	9.10	21.00
600	0.40-0.53	0.70	1.20	2.40	4.60	10.80
1800	0.10-0.18	0.20-0.29	0.34-0.42	0.80	1.60	3.60







Camera Calculations



 $AFOV(^{\circ}) = 2 x \tan^{-1}\left(\frac{h}{2f}\right)$

h = 2.7mm

 $2\arctan(\frac{2.70}{2f}) = 5^{\circ}$

 $f_{desired} = 30.92mm$

 $f_{actual} = 30mm$

$$2\arctan(\frac{2.70}{2(30)}) = 5.16^\circ$$

Camera Feasibility

	(C	
2		

Design Constraint	Criteria	Design	Feasibility
Size	Focal length less than 10cm	Focal length 3cm	\checkmark
Field of View	2-10° FOV	5.16° FOV	\checkmark
Price	< \$100	\$51	\checkmark
Power	< 1W	.6W while in operation	\checkmark
Data Storage	128GB	45GB taken throughout flight	\checkmark

Sensors

Sensor Type	Model	Specifications	Price
	Environme	ntal Sensors	
Pressure	Honeywell ASDX-series	0 to 15 psi (up to 103 kPa)	\$44.71
Humidity	TE HPP804B130	1-99% RH	\$19.70
Temperature	TMP102	-55 to +150 °C	\$3.95
	Housekeep	ing Sensors	
Temperature	DS18B20	-55 to +125 °C	\$3.95

ENV Feasibility: Pressure

Honeywell ASDX-series Barometric Pressure Sensor

ASDXACX015PA7A5 Sensing Range 0 to 15psi (to 103 kPa)

Sold through Digikey, Arrow Electronics, other vendors

17 mm-17 mm-14 mm

I2C or SPI digital interface options

\$45





ENV Feasibility: Humidity

TE Humidity Temperature Sensor HPP804B130

Operating Range -60 to +140 °C

Sensing Range 1-99% RH, 1% error

Analog Output, requires an ADC

\$19.70 from Digikey





ENV Feasibility: Temperature

Digital Temperature Sensor Breakout with TMP102

> Sensing range -55 to +150 °C, error 0.75 °C

> I2C digital interface

> \$3.95 from SparkFun



HK Feasibility: Temperature

DS18B20 Digital temperature sensor

>\$3.95 from Adafruit

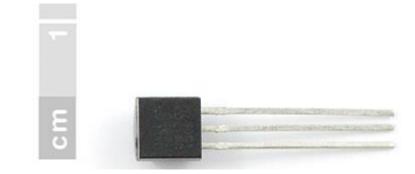
> Sensing Range -55 to +125 °C, error 0.5 °C above -10 °C

>x3:

Microprocessor

Batteries

Solar Panel Array



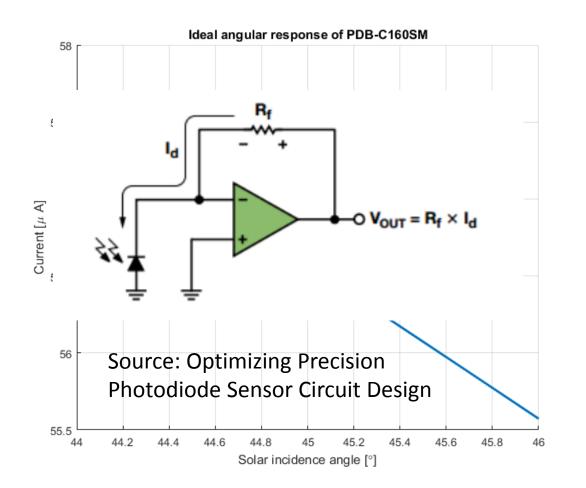
Data Storage Feasibility

>Measurements being taken:

- >Spectrometer: one 4 kB spectra every second
- >Camera: one 2.5 MB image every minute
- Environmental: measure temperature, pressure, humidity every second
- Housekeeping: 2 voltmeters, 2 ammeters, 3 thermistors every second
- Attitude: 4 photodiodes and computed angle every second



Attitude Determination Feasibility



- Solar incidence angle on each photodiode is nominally $45^{\circ} \pm 1^{\circ}$.
- Angular sensitivity in this range:
 - > Average slope: -16.4543 nA/arcminute
 - Standard deviation: 0.1665 nA/arcminute
 - Minimum: -16.7374 nA/arcminute
 - Maximum: -16.1679 nA/arcminute

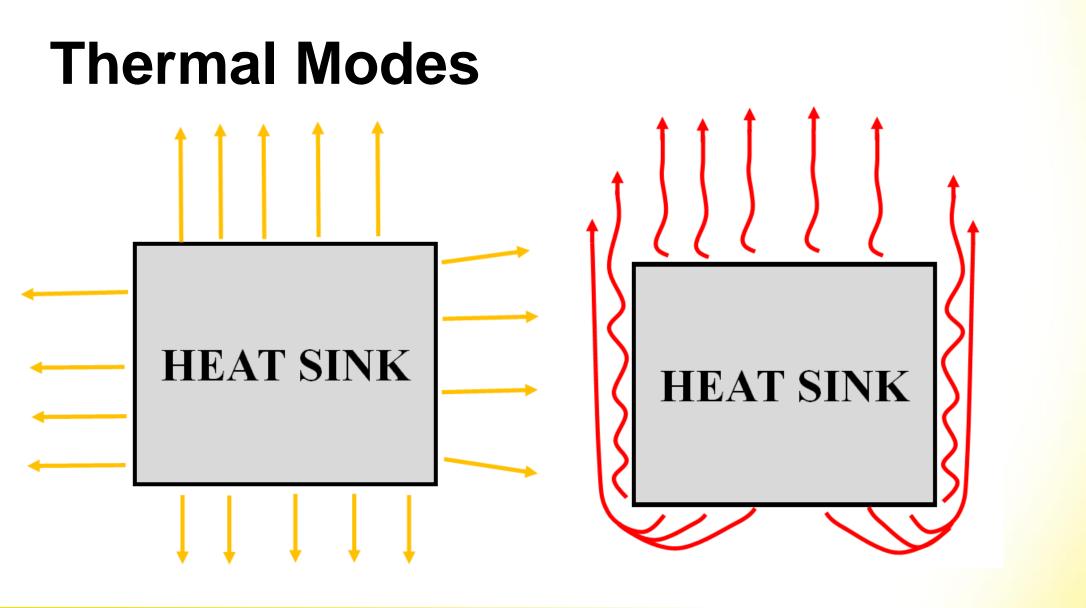
Measuring nA

- Use op amp and resistor to magnify signal
- > Signal into ADC
- Digital signal read by Pi

Attitude Determination Feasibility



Requirement	Description	Feasibility
4.1	The off-sun angle shall be determined to ± 1 arcminute.	\checkmark
4.2	Attitude data shall be recorded synchronously with other science data at a rate of one measurement per minute.	



Thermal Assumptions

> Bulk temperatures (No transience within components)

Perfect connections

> No forced convection (wind)

> Thermal conductivity of air decreases with pressure linearly

> No heat from solar panels or HiWind interface

> No Reflectivity

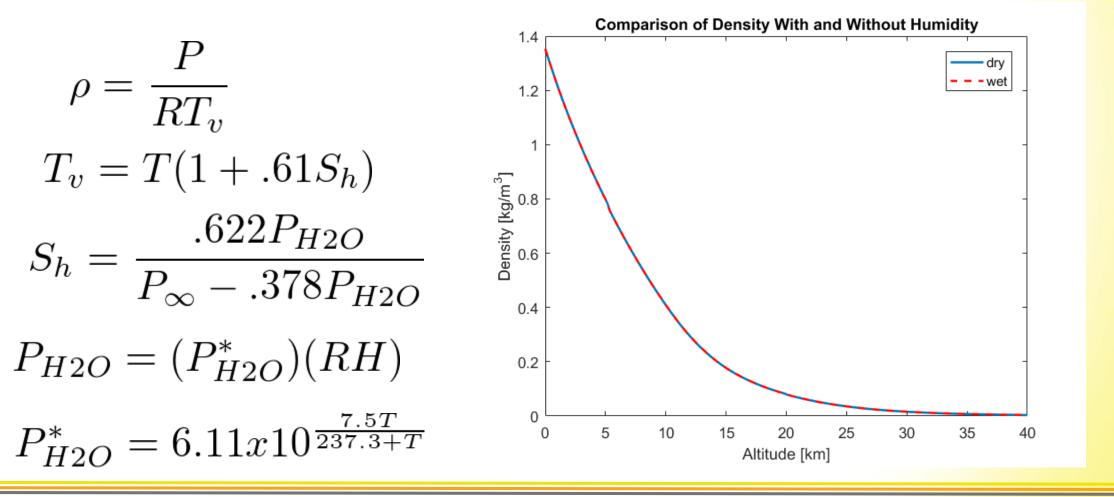


Thermal Convection Equations

$$\dot{Q} = hA\Delta T$$
 $h = \frac{k}{L_c}Nu$ $Ra = \frac{gC_p\rho\beta(T_s - T_\infty)L_c^3}{k\nu}$

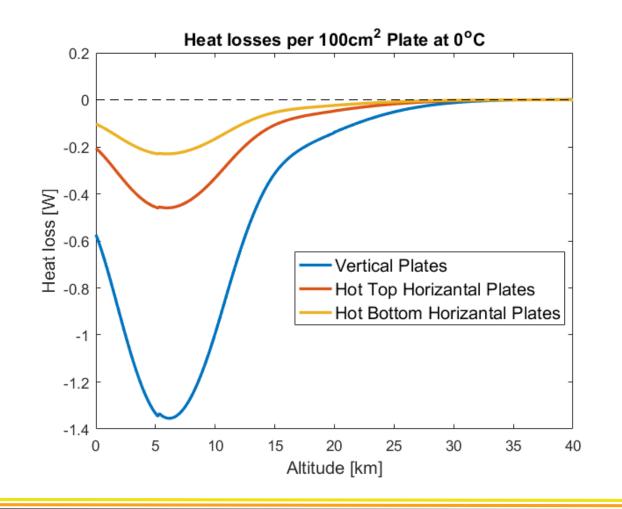
Nusselt Number Table	Range of Ra	Nu	Characteristic Length
Vertical Plate	all	$Nu = \left(.825 + \frac{.387RA_L^{1/6}}{[1 + (.492/Pr)^{9/16}]^{8/27}}\right)^2$	Н
Horizontal Plate Top Side	$10^4 - 10^7$ $10^7 - 10^{11}$	$Nu = .54 Ra_L^{1/4}$ $Nu = .15 Ra_L^{1/3}$	$L_c = \frac{A_s}{P}$
Horizontal Plate Bottom Side	10 ⁵ – 10 ¹¹	$Nu = .27 Ra_L^{1/4}$	$L_c = \frac{A_s}{P}$

Humidity Corrections



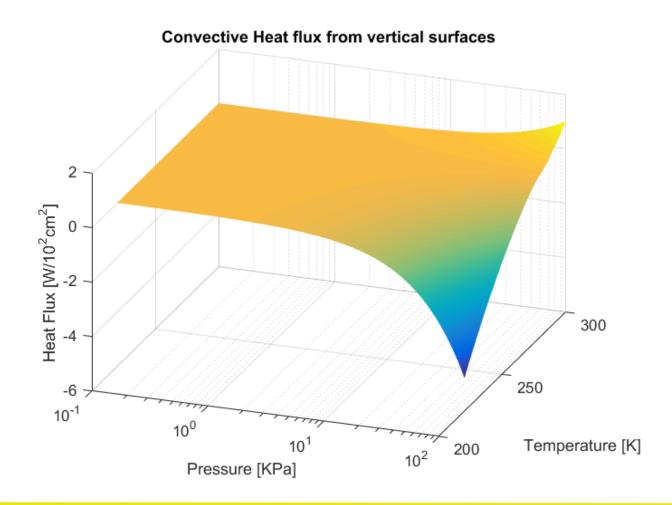


Convective Losses



- Maximum convection occurs at 7 km
- Vertical plates convect more
- Upper plates have greater convection than lower plates

Convection Solution Space





Thermal Radiation Equations

Heat Radiated

 $\dot{Q} = \sigma A T^4 \epsilon$

Heat Absorbed

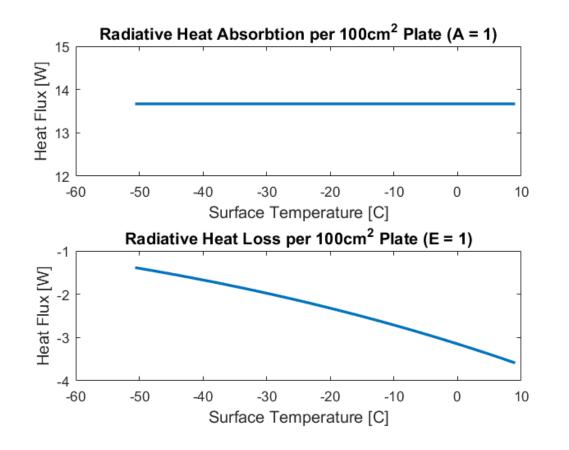
$$\dot{Q}_{in} = \dot{Q}_{Source} A \alpha$$

 $\sigma = 5.6703 x 10^{-8}$

 $\dot{Q}_{Ground} \approx 1050 [W/m^2]$ $\dot{Q}_{Ground+Albedo} \approx 1120 [W/m^2]$ $\dot{Q}_{Vacuum} \approx 1367 [W/m^2]$



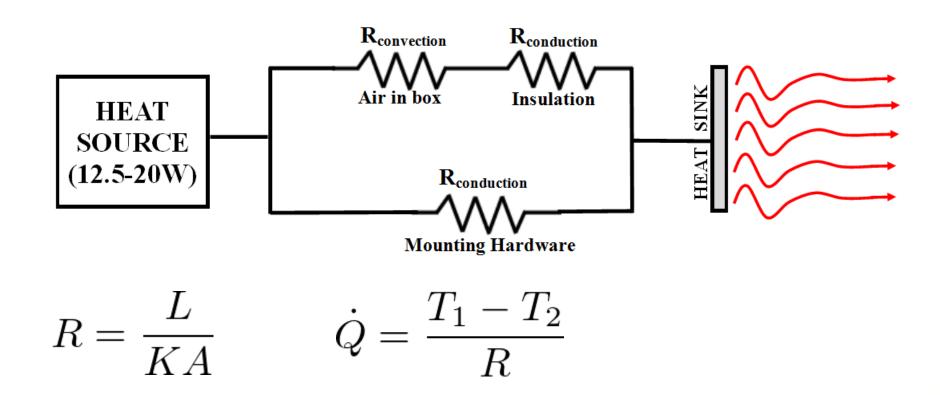
Radiative Losses



- One panel will be pointed toward the sun

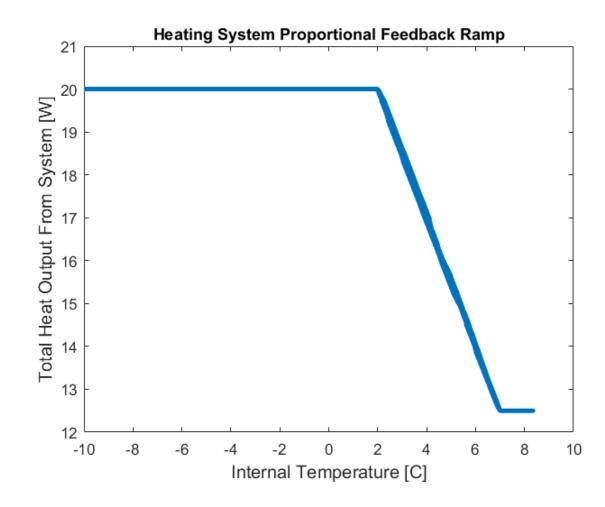
The other 11 will be exposed to minimal solar radiation

Insulation Equations





Active Control Heating Ramp



- Variable heating to prevent too much power draw through flight
- 2° buffer between max heat and min internal temperature
- Cruise is at about 13.5 W

Thermal Model Inputs

- Mass of external structure: 2 kg (c = 900 J/kgK)
- Mass of internal structure: 2 kg (c = 500 J/kgK)
- Thickness of insulation: 1 cm
- Emissivity/Absorptivity: .7/.3
- Min/Max power draw: 12.5/20 W
- Ascent Time: 2 hrs
- Mounting Hardware Resistivity: 3 K/W

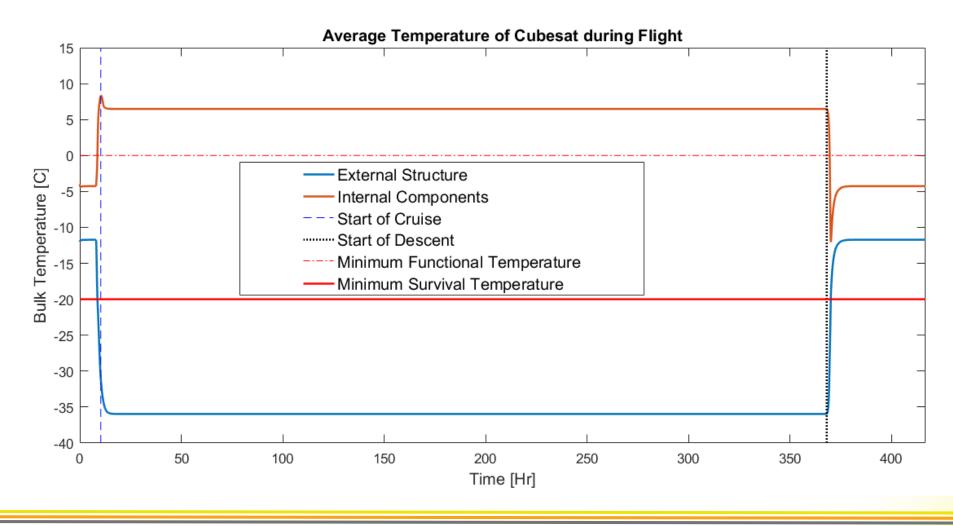
Thermal ODE Explanation



This thermal problem is a STIFF problem that cannot be solved trivially

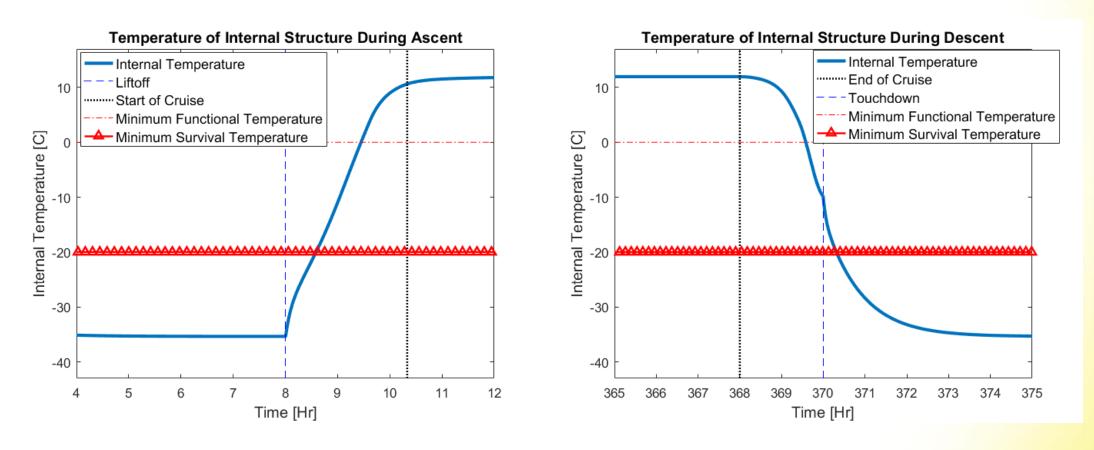
ODE15S employed rather than ODE45 (ODE45 diverges)

Full Thermal Simulation



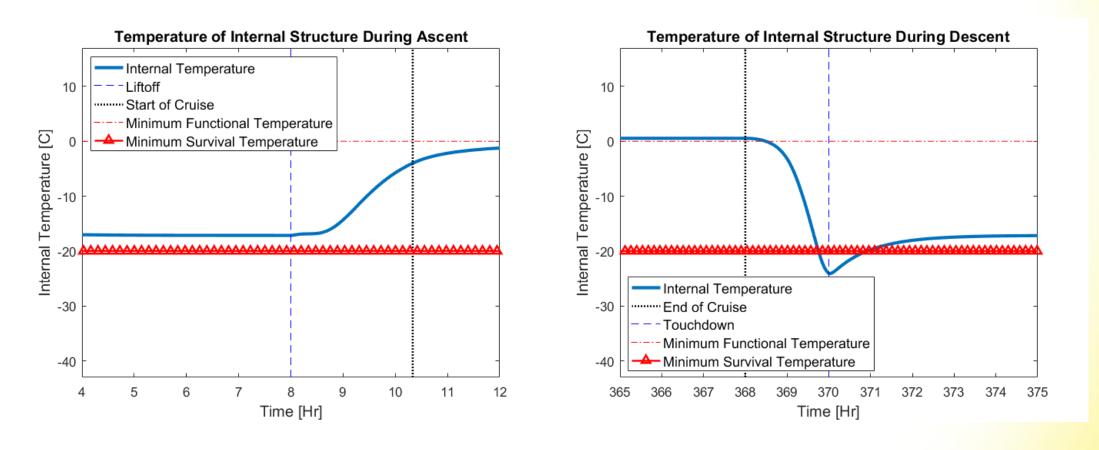


No Power on Ground Case





No Active Heating Case





Known Thermal Issues



Solar panels and interface are not accounted for yet

>Wind not accounted for yet

Surface of box not yet determined (outgassing issues)

Interface Summary



Component	Size	Weight	Power	Data
Spectrometer	129.2 cm ³	0.174 kg	1.25 W	30 MB/s
Pressure Sensor	2.569 cm ³	N/A	0.0125 W	12.5 kB/s
Humidity Sensor	0.189 cm ³	N/A	0.02 W	12.5 kB/s
Temperature Sensor (ENV)	0.228 cm ³	N/A	0.288 W	12.5 kB/s
Temperature Sensor (HK)	0.111 cm ³	N/A	0.02 W	12.5 kB/s
Camera	5.369 cm ³	0.003 kg	0.7 W	30 MB/s

Interface Summary



Group	Component	Size	Weight	Power	Data
C&DH	Raspberry Pi	80.920 cm ³	0.045 kg	6 W	N/A
	Flash Drive	2.450 cm ³	0.002 kg	0.940 W	N/A
	Diodes	0.0237 cm ³	N/A	0.215 W	12.5 kB/s
EPDS	Solar Cells	170.640 cm ³	0.288 kg	12.948 W	N/A
	Battery	108.0375 cm ³	0.191 kg	21.6 W	N/A
Thermal	Resistive Heaters	2.048 cm ³	0.042 kg	5 W	N/A